

RL78/G1E Group

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Example of Measurement Using a Piezoelectric Sensor

Introduction

This application note describes how to measure a physical quantity (acceleration) based on the electric charge generated by a piezoelectric sensor, by using the configurable amplifier, A/D converter, and D/A converter incorporated in the RL78/G1E (R5F10FMx).

In this application note, the shock sensor PKGS-00LD-R (made by Murata Manufacturing Co., Ltd.) is used as the piezoelectric sensor.

Operation Verified Devices

RL78/G1E (R5F10FMx (x = C, D, or E))

When this application note is applied to other microcontrollers, make the necessary changes according to the specifications of the microcontroller and verify them thoroughly.

Contents

1.	Sp	ecifica	ations	3
2.	Co	onditio	ns for Verifying Operation	4
3.	Re	elated	Application Notes	4
4.	Ha	ardwar	e	5
	4.1	H	lardware Configuration Example	5
	4.2		unctions Used	
	4.3		rins Used	
5.	De	escript	ion of Features	8
	5.1	F	Piezoelectric Sensor	8
		5.1.1	Overview of piezoelectric sensors	8
		5.1.2	Overview of shock sensor (PKGS-00LD-R)	9
	5.2	C	Configurable Amplifier (Used As a Differential Amplifier)	10
		5.2.1	Example of general amplifier and signal converter	
		5.2.2	Example of amplifier and signal converter configured by using a configurable amplifier	
			and used to amplify and convert the shock sensor output voltage	11
	5.3	A	√D Converter	
		5.3.1	Overview of A/D converter incorporated in RL78/G1E (R5F10FMx)	
		5.3.2	Connecting the configurable amplifier Ch2 (used as a non-inverting amplifier) to the	
			A/D converter	13
	5.4	C	CPU (Arithmetic Operation)	
	5.5		CD Module	
6.	Ar	nalog E	Block of RL78/G1E (R5F10FMx)	16
-	6.1		Overview of Analog Block of RL78/G1E (R5F10FMx)	
	6.2		unctions of Analog Block of RL78/G1E (R5F10FMx)	
		6.2.1	Configurable amplifier	
		6.2.2	Reference voltage generator and variable output voltage regulator	
		6.2.3	D/A converter	
		6.2.4	SPI	
	6.3		Settings of SPI Control Registers of RL78/G1E (R5F10FMx)	_
7.	Mi	crocoi	ntroller Block of RL78/G1E (R5F10FMx)	38
•	7.1		functions Assigned to the Microcontroller Block of the RL78/G1E (R5F10FMx)	
	7.2		unctions of the Microcontroller Block of the RL78/G1E (R5F10FMx)	
		7.2.1	High-speed on-chip oscillator (clock generator)	
		7.2.2	SPI control	
		7.2.3	A/D converter	
		7.2.4	Timer array unit 0	
		7.2.5	LCD module control	
		7.2.6	Peak detector control	
	7.3		Software	
		7.3.1	Timing charts	
		7.3.2	Register settings specified for the microcontroller block of the RL78/G1E (R5F10FMx).	
		7.3.3	Functions	
		7.3.4	Function specifications	
		7.3.5	RAM variables	
		7.3.6	Flowcharts	
		7.3.7	Source files and changes applied to the code output from the code generator	
		0.7		-

1. Specifications

This application note describes how a piezoelectric sensor is used by providing an example of a system in which the RL78/G1E (R5F10FMx) is used to measure the acceleration based on the differential voltage produced by an electric charge output from a shock sensor (PKGS-00LD-R).

In this application note, a case is presented in which an electric charge output from a shock sensor is converted to a single-ended voltage and then amplified by using the configurable amplifier (used as a differential amplifier) incorporated in the RL78/G1E (R5F10FMx).

The single-ended voltage output from the shock sensor is converted and amplified, the peak voltage is detected and held in a peak detector, which consists of a diode and a capacitor, and then the resulting signal is amplified by the configurable amplifier (non-inverting amplifier) incorporated in the RL78/G1E (R5F10FMx). The voltage output from the configurable amplifier (non-inverting amplifier) is further converted to a digital value by using the A/D converter incorporated in the RL78/G1E (R5F10FMx).

The acceleration is calculated from the obtained digital value, and the result is displayed on the LCD module (ACM0802C) connected to the RL78/G1E (R5F10FMx).

Figure 1.1 shows a block diagram, and Table 1.1 shows the elements included in the block diagram.

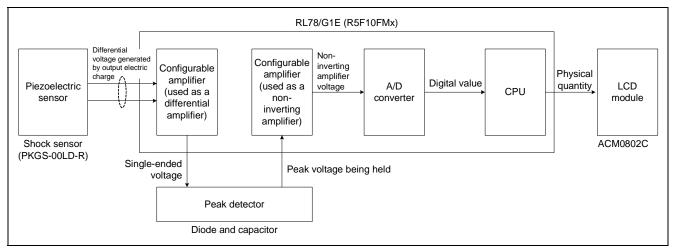


Figure 1.1 Block Diagram

Table 1.1 Description of the Elements in the Block

Element	Function	Description
Shock sensor (PKGS-00LD-R)	Piezoelectric sensor	Sensor that outputs an electric charge in accordance with the acceleration
Diode and capacitor	Peak detector	Holds the peak voltage output from the configurable amplifier (used as a differential amplifier).
RL78/G1E (R5F10FMx)	Configurable amplifier (used as a differential amplifier)	Converts the differential voltage output from the shock sensor to a single-ended voltage and amplifies it.
	Configurable amplifier (used as a non-inverting amplifier)	Amplifies the output from the peak detector (peak voltage being held).
	A/D converter	Converts the analog voltage output from the configurable amplifier (used as a non-inverting amplifier) to a digital value.
	CPU	Calculates the physical quantity (acceleration) from the digital value converted by the A/D converter.
ACM0802C	LCD module	Displays the physical quantity (acceleration) calculated by the CPU.

2. Conditions for Verifying Operation

The operation of the sample code shown in this application note has been verified under the conditions shown below.

Table 2.1 Conditions for Verifying Operation

Item	Description		
Microcontroller used	RL78/G1E (R5F10FME)		
Operating frequency	High-speed on-chip oscillator (high-speed OCO) clock: 32 MHz		
	CPU/peripheral hardware clock: 32 MHz		
Operating voltage	V_{DD} , DV_{DD} , AV_{DD1} , AV_{DD2} , AV_{DD3} , and LCD module power supply: 5.0 V		
	AV _{DD} : 3.3 V		
	LVD detection voltage (V _{LVIH}): 4.06 V when rising, 3.98 V when falling		
External devices used	Shock sensor (PKGS-00LD-R)		
	Peak detector		
	 Diode (HSM107S; VF = 0.3 V (max.)) 		
	- Capacitor (0.33 μF, laminated ceramic capacitor)		
	LCD module (ACM0802C-NLW-BBH)		
Integrated development	CubeSuite+ V1.01.01 [31 Jan 2012] made by Renesas Electronics		
environment			
C compiler (build tool)	CA78K0R V1.30 made by Renesas Electronics		

3. Related Application Notes

Related application notes are shown below. Also refer to these documents when using this application note.

- RL78/G13 Initialization (R01AN0451E) Application Note
- RL78/G13 Timer Array Unit (Interval Timer) (R01AN0456E) Application Note
- RL78/G13 Serial Array Unit for 3-Wire Serial I/O (Master Transmission/Reception) (R01AN0460E) Application Note

4. Hardware

4.1 Hardware Configuration Example

Figure 4.1 shows an example of the hardware configuration described in this application note.

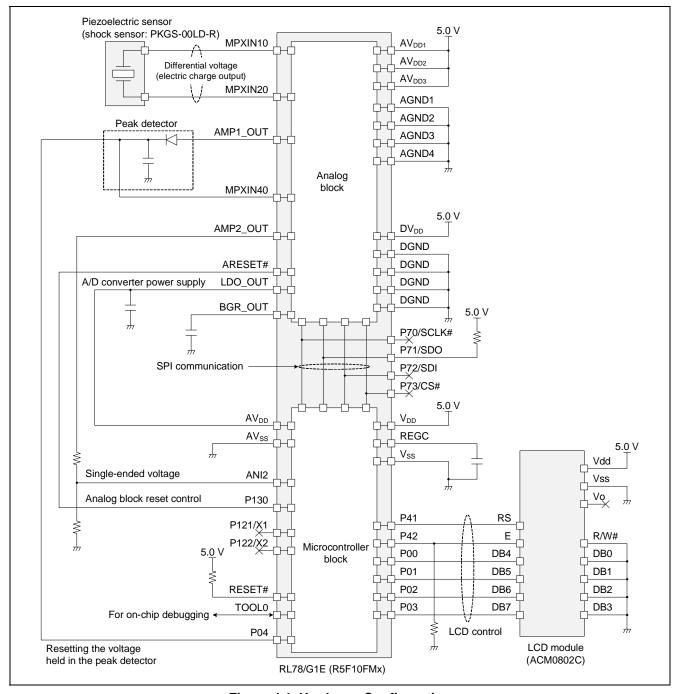


Figure 4.1 Hardware Configuration

Caution This circuit diagram is simplified to show an overview of the circuit connection. When designing an actual circuit, connect pins appropriately so as to satisfy the electrical specifications. (Connect unused input-only ports individually to V_{DD} or V_{SS} via a resistor.)

4.2 Functions Used

Table 4.1 shows the RL78/G1E (R5F10FMx) peripheral functions used in this application note and their applications.

Table 4.1 RL78/G1E (R5F10FMx) Peripheral Functions and Their Applications

	8/G1E (R5F10FMx) Peripheral ction	Application	
olock	Configurable amplifier Ch1	Used as a differential amplifier that converts the differential voltage output from a shock sensor to a single-ended voltage and amplifies it.	
Analog block	Configurable amplifier Ch2	Used as a non-inverting amplifier that amplifies the voltage held in the peak detector.	
An	D/A converter	Generates a bias voltage for the configurable amplifier (used as a differential amplifier or non-inverting amplifier).	
	Variable output voltage regulator	Generates the power supply voltage for the A/D converter.	
	SPI	Controls SPI communication with the microcontroller block of the RL78/G1E (R5F10FMx).	
olock	A/D converter	Converts the voltage output from the configurable amplifier (used as a non-inverting amplifier) to a digital value.	
Microcontroller block	Serial array unit 1 (channel 1: CSI21)	Controls SPI communication with the analog block by using the 3-wire serial I/O function.	
ntr	I/O ports	Controls the analog block, external LCD module, and peak detector.	
000	Timer array unit 0 (channel 1)	Generates a hardware trigger signal for the A/D converter.	
licr	Timer array unit 0 (channel 3)	Generates the wait time used by software.	
2	High-speed on-chip oscillator (high-speed OCO)	Generates the 32 MHz clock used as the main system clock.	

4.3 Pins Used

Table 4.2 shows the RL78/G1E (R5F10FMx) pins used in this application note and their features.

Table 4.2 RL78/G1E (R5F10FMx) Pins Used and Their Features

Pin Name	I/O	Description
MPXIN10	Input	This is an inverted input pin of the configurable amplifier Ch1 (used as a differntial amplifier) in the analog block. The differential output voltage from the shock sensor is input to this pin.
MPXIN20	Input	This is a non-inverted input pin of the configurable amplifier Ch1 (used as a differntial amplifier) in the analog block. The differential output voltage from the shock sensor is input to this pin.
AMP1_OUT	Output	This is an output pin of the configurable amplifier Ch1 (used as a differntial amplifier) in the analog block. This pin is connected to the input stage of the peak detector.
MPXIN40	Input	This is a non-inverted input pin of the configurable amplifier Ch2 (used as a non-inverting amplifier) in the analog block. The output voltage from the peak detector is input to this pin.
AMP2_OUT	Output	This is an output pin of configurable amplifier Ch2 (used as a non-inverting amplifier) in the analog block. This pin is connected to the ANI2 pin of the A/D converter in the microcontroller block via a resistor divider.
ANI2	Input	This is an analog input pin of the A/D converter in the microcontroller block. This pin is connected to the AMP2_OUT pin in the analog block via a resistor divider which steps down the output voltage from the AMP2_OUT pin. The output voltage stepped down is to be A/D converted.
P130	Output	P130 is an output-only pin in the microcontroller block. This pin is connected to the ARESET# pin in the analog block and is used to control the analog reset feature of the analog block.
P41	Output	P41 is an output pin in the microcontroller block. This pin is connected to the RS pin in the LCD module and is used to control the LCD module display.
P42	Output	P42 is an output pin in the microcontroller block. This pin is connected to the E pin in the LCD module and is used to control the LCD module display.
P00	Output	P00 is an output pin in the microcontroller block. This pin is connected to the DB4 pin in the LCD module. This pin is used to control the LCD module display.
P01	Output	P01 is an output pin in the microcontroller block. This pin is connected to the DB5 pin in the LCD module and is used to control the LCD module display.
P02	Output	P02 is an output pin in the microcontroller block. This pin is connected to the DB6 pin in the LCD module and is used to control the LCD module display.
P03	Output	P03 is an output pin in the microcontroller block. This pin is connected to the DB7 pin in the LCD module and is used to control the LCD module display.
P04	Output	P04 is a N-ch open-drain output pin in the microcontroller block. This pin is used to reset the voltage held in the peak detector after the input voltage to the ANI2 pin is A/D converted.

5. Description of Features

5.1 Piezoelectric Sensor

This section provides an overview of typical piezoelectric sensors and the characteristics and operation of the shock sensor PKGS-00LD-R (made by Murata Manufacturing Co., Ltd.).

5.1.1 Overview of piezoelectric sensors

The following devices typically use piezoelectric elements, or similar elements that provide small, differential voltage outputs:

- Pyroelectric infrared sensor
 - A pyroelectric infrared sensor is a sensor that uses the pyroelectric effect in which an electric charge (polarization) occurs due to a temperature change in the element. This sensor is used in applications such as motion sensors that sense the infrared rays radiated by humans.
- Piezoelectric ceramic force/vibration/shock sensors

 When stress is applied, piezoelectric ceramics generate electric charges proportional to the stress. Piezoelectric ceramics feature a high electromechanical conversion efficiency and superior mass production capability.

5.1.2 Overview of shock sensor (PKGS-00LD-R)

An overview of the shock sensor PKGS-00LD-R is shown below.

The following shows the electrical characteristics extracted from the data sheet of the shock sensor PKGS-00LD-R that were referenced when studying the product in this application note. Before using the product, be sure to download the latest data sheet from the Murata Manufacturing website.

The extracted specifications of the shock sensor PKGS-00LD-R are shown in **Table 5.1**.

Table 5.1 Shock Sensor PKGS-00LD-R Extracted Specifications

Primary Axis Inclined Angle (°)	Sensitivity (pC/G)	Capacitance (pF)	Insulation Resistance (MΩ)	Resonant Frequency (kHz)	Non-linearity (%)
0	0.840	770	500	20	1
	(Typ.)	(Typ.)	(Min.)	(Typ.)	(Typ.)

The relationship between electric charge Q(C), capacitance C(F), and voltage V(V) is expressed by using the following formula, based on the definition of capacitance:

$$Q = C \times V$$
 ... Formula 1

According to the specification of the shock sensor PKGS-00LD-R, the sensitivity of an electric charge is 0.84 pC/G and the sensor capacitance is 770 pF. Therefore, *Formula 1* is expressed as follows, where g (G) is acceleration:

$$0.84 p \times g = 770 p \times V$$
 ... Formula 2

Based on *Formula 2*, the sensitivity of the shock sensor PKGS-00LD-R converted to voltage is expressed by using the following formula:

$$V = 1.1 \times 10^{-3} \times g$$
 ... Formula 3

Based on *Formula 3*, the sensitivity of the shock sensor PKGS-00LD-R (the relationship between output voltage and acceleration) is as shown in **Figure 5.1**.

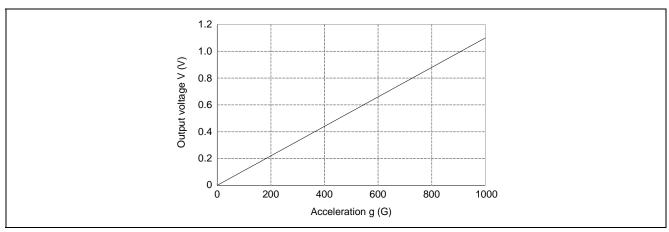


Figure 5.1 Sensitivity of Shock Sensor PKGS-00LD-R

5.2 Configurable Amplifier (Used As a Differential Amplifier)

This section shows how a differential voltage signal output from the piezoelectric sensor is amplified by using two different methods: a general amplifier and signal converter, and an amplifier and signal converter that are configured by using the configurable amplifier of the RL78/G1E (R5F10FMx).

5.2.1 Example of general amplifier and signal converter

The shock sensor used in this application note outputs a differential voltage that varies according to the generated electric charge. To amplify the sensor output signal and convert it to a single-ended voltage signal, a differential amplifier is used. A general differential amplifier is shown in **Figure 5.2**.

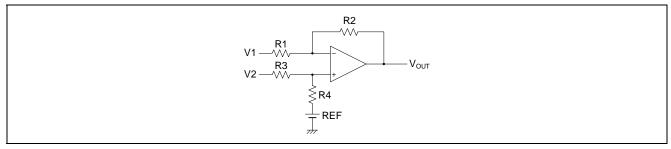


Figure 5.2 General Differential Amplifier

A differential amplifier amplifies the difference between two input voltages and converts the result to a single-ended voltage to be output. The output voltage is obtained by using the following formula, where R1 = R3 and R2 = R4:

$$V_{OUT} = (V2 - VI) \times \frac{R2}{RI} + REF$$
 ... Formula 4

The shock sensor outputs a voltage in a very short period. Therefore, some signals might fail to be sampled for A/D conversion, depending on the timing. In this application note, a peak detector is used to accurately sample the peak of the voltage output from the shock sensor.

The peak detector is a circuit that detects and holds the peak of an input voltage for a specific period. **Figure 5.3** shows a general peak detector.

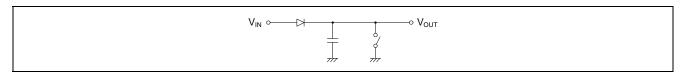


Figure 5.3 General Peak Detector

The voltage held by the peak detector is expressed by using the following formula, where VF is the forward voltage of the diode:

$$V_{OUT} = V_{IN} - VF$$
 ... Formula 5

Because the peak detector holds the peak of the input voltage, once a peak voltage is held, voltages lower than the peak can no longer be measured. To measure the voltage repeatedly, therefore, the previous held voltage must be reset before the next one is measured.

5.2.2 Example of amplifier and signal converter configured by using a configurable amplifier and used to amplify and convert the shock sensor output voltage

Figure 5.4 shows an example of an amplifier and signal converter that are configured by using the configurable amplifier incorporated in the RL78/G1E (R5F10FMx) and used to amplify and convert the voltage output from the shock sensor (differential voltage).

In this application note, configurable amplifier Ch1 is used as a differential amplifier to convert the voltage output from the shock sensor (differential voltage) to a single-ended voltage and amplify it.

A shock sensor outputs the peak voltage very fast, therefore this voltage is held at its peak value by an external peak detector. The peak voltage is amplified by configurable amplifier Ch2 (non-inverting amplifier), and then A/D-converted by the A/D converter incorporated in the RL78/G1E (R5F10FMx). The acceleration is then calculated based on this A/D-converted value.

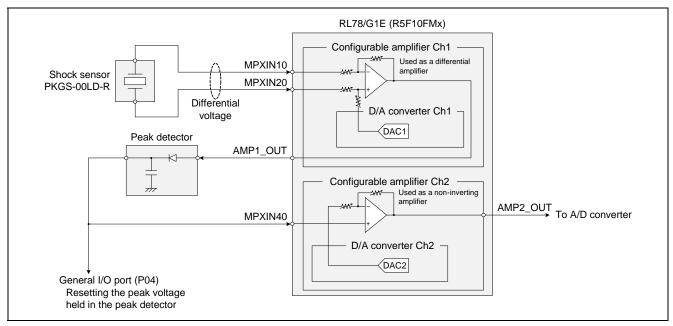


Figure 5.4 Amplifier and Signal Converter for Amplifying and Converting Shock Sensor Output Voltage

AMP1_OUT (V), the voltage output from configurable amplifier Ch1 (used as a differential amplifier), is expressed by using the following formula, based on *Formula 4*, where GAIN1 is the gain in configurable amplifier Ch1 (used as a differential amplifier) and DAC1 (V) is the voltage output from D/A converter Ch1:

$$AMP1_OUT = (MPXIN20 - MPXIN10) \times GAIN1 + DAC1$$
 ... Formula 6

If the D/A converter Ch1 output voltage (DAC1) is 0 V and the gain in configurable amplifier Ch1 (used as a differential amplifier) is two times, *Formula 6* is expressed as follows:

$$AMP1 OUT = (MPXIN20 - MPXIN10) \times 2$$
 ... Formula 7

Based on Formula 5, MPXIN40 (V), the voltage input to configurable amplifier Ch2 (non-inverting amplifier), is expressed by using the following formula, where VF (V) is the forward voltage in the diode included in the peak detector:

$$MPXIN40 = AMP1 OUT - VF$$
 ... Formula 8

AMP2_OUT (V), the voltage output from configurable amplifier Ch2 (used as a non-inverting amplifier), is expressed by using the following formula, where GAIN2 is the gain in configurable amplifier Ch2 (used as a non-inverting amplifier) and DAC2 (V) is the voltage output from D/A converter Ch2:

$$AMP2 \ OUT = MPXIN40 \times GAIN2 - DAC2 \times (GAIN2 - 1)$$
 ... Formula 9

If *Formula* 8 and *Formula* 6 are applied to *Formula* 9, the voltage output from configurable amplifier Ch2 (used as a non-inverting amplifier) (AMP2_OUT) is expressed by using the following formula:

$$AMP2_OUT = ((MPXIN20 - MPXIN10) \times GAIN1 + DAC1 - VF) \times GAIN2 - DAC2 \times (GAIN2 - 1)$$
 ... Formula 10

If the D/A converter Ch1 output voltage (DAC1) is 0 V, the gain in configurable amplifier Ch1 (used as a differential amplifier) is two times, the gain in configurable amplifier Ch2 (used as a non-inverting amplifier) is four times (12 dB), DAC2 is 0 V, and the forward voltage (VF) of the diode (HSM107S) used in the peak detector is 0.3 V (Max.) according to the data sheet, the relationship between the input and output in the configurable amplifier is expressed by using the following formula, based on *Formula 10*:

$$AMP2_OUT = ((MPXIN20 - MPXIN10) \times 2 - 0.3) \times 4$$

= $(MPXIN20 - MPXIN10) \times 8 - 1.2$... Formula 11

Figure 5.5 shows the relationship between the voltage output from the shock sensor (PKGS-00LD-R) (differential voltage) and configurable amplifier Ch1 (used as a differential amplifier) (AMP1_OUT) calculated from *Formula 7*, and the relationship between the voltage output from the shock sensor (PKGS-00LD-R) (differential voltage) and configurable amplifier Ch2 (used as a non-inverting amplifier) (AMP2_OUT) calculated from *Formula 11*.

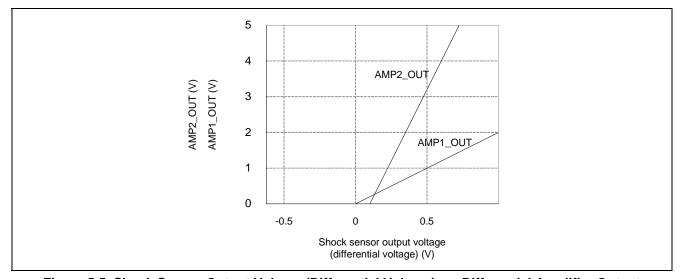


Figure 5.5 Shock Sensor Output Voltage (Differential Voltage) vs. Differential Amplifier Output (AMP1_OUT) and Non-Inverting Amplifier Output (AMP2_OUT)

Note The period during which the peak voltage is held by the peak detector is determined by the reverse current characteristics of the diode and leakage current characteristics of the capacitor. The voltage drop in the peak detector is determined by the forward voltage (VF) of the diode. The user needs to select hardware components that meet their system requirements.

5.3 A/D Converter

This section describes the A/D converter incorporated in the RL78/G1E (R5F10FMx), which is used to convert the shock sensor output differential voltage signal amplified and converted to a digital value by configurable amplifier Ch1 (used as a differential amplifier), the peak detector, and configurable amplifier Ch2 (used as a non-inverting amplifier).

5.3.1 Overview of A/D converter incorporated in RL78/G1E (R5F10FMx)

The A/D converter incorporated in the RL78/G1E (R5F10FMx) is used to convert an analog input to a digital value. Seventeen analog input channels are available for analog input. 12-bit resolution or 8-bit resolution can be selected.

The settings specified for the A/D converter incorporated in the RL78/G1E (R5F10FMx) are shown below.

■ Trigger mode: Hardware trigger no-wait mode

■ Channel selection mode: Select mode

■ Conversion mode: One-shot conversion mode

Analog input pin: ANI2Conversion resolution: 12 bits

Reference voltage: $AV_{DD} = 3.3 \text{ V}, AV_{SS} = 0 \text{ V}$

5.3.2 Connecting the configurable amplifier Ch2 (used as a non-inverting amplifier) to the A/D converter

The maximum power supply voltage of the A/D converter incorporated in the RL78/G1E (R5F10FMx) is 3.6 V. The power supply voltage used in this application note is 5.0 V, so a stepped down voltage must be supplied to the A/D converter. To achieve this, the output voltage from the variable output voltage regulator in the analog block is set to be 3.3 V (Typ.), which is supplied to the AV_{DD} pin.

Connect the output pin (AMP2_OUT) of configurable amplifier Ch2 (used as a non-inverting amplifier) in the analog block to the ANI2 analog input pin of the A/D converter. Note that the analog voltage output from the AMP2_OUT pin in the analog block is 0 to 5 V. To make the output voltage from AMP2_OUT lower than AV_{DD} , therefore, step down it to 0 to 3 V by using a resistor divider and input it to the ANI2 analog input pin of the A/D converter.

Figure 5.6 shows the connection between configurable amplifier Ch2 (used as a non-inverting amplifier) and the A/D converter incorporated in the RL78/G1E (R5F10FMx).

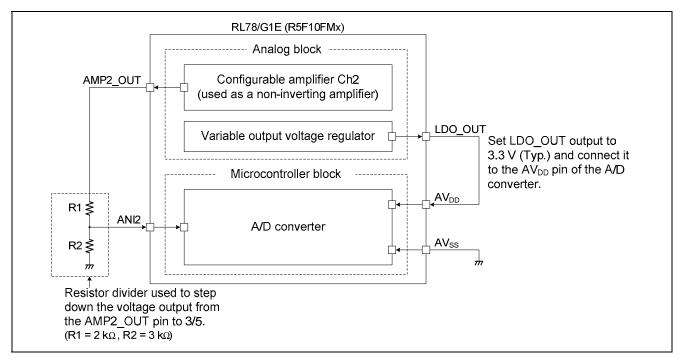


Figure 5.6 Connection Between Configurable Amplifier Ch2 (Used As a Non-Inverting Amplifier) and A/D Converter

5.4 CPU (Arithmetic Operation)

This section describes how the CPU calculates the physical quantity (acceleration) based on the A/D conversion result.

The analog voltage input to the ANI2 pin, which is calculated from the A/D conversion result (stored in the 12-bit A/D conversion result register (ADCR)) is expressed as shown in the formula below:

$$ANI2 = \frac{AD_conversion_value}{2^{12}-1} \times AV_{DD}$$
 ... Formula 12

AV_{DD}: Power supply voltage input to the A/D converter (V)

ANI2: Voltage input to analog input pin 2 of the A/D converter (V)

Because the analog voltage output from the AMP2_OUT pin is divided by using the resistor divider and then input to the ANI2 pin, the AMP2_OUT pin voltage (V) is expressed as shown in the formula below (see *Figure 5.6*):

$$AMP2_OUT = ANI2 \times \frac{R1 + R2}{R2}$$
 ... Formula 13

If Formula 12 and Formula 10 are applied to Formula 13, the formula below is obtained. The voltage (differential voltage) input to configurable amplifier Ch1 (used as a differential amplifier) is expressed by using the following formula:

$$\frac{AD_conversion_value}{2^{12}-1} \times AV_{DD} \times \frac{RI+R2}{R2} + DAC2 \times (GAIN2-1) \\ -\frac{CAIN2}{GAIN1} + VF-DAC1$$
 ... Formula 15

The acceleration (G) (physical quantity) is obtained from the voltage output from the shock sensor, by using the following formula, based on *Formula 3*:

$$Acceleration = \frac{1}{1.1 \times 10^{-3}} \times Sensor_output_voltage \qquad ... \quad Formula 16$$

Based on Formula 15 and Formula 16, the acceleration (G) (physical quantity) is expressed by using the following formula:

$$Acceleration = \frac{1}{1.1 \times 10^{-3}} \times \frac{\frac{AD_conversion_value}{2^{12}-1} \times AV_{DD} \times \frac{RI+R2}{R2} + DAC2 \times (GAIN2-1)}{GAIN2} + VF - DAC1}{GAIN1} \qquad \qquad \textbf{Formula 17}$$

If $AV_{DD} = 3.3 \text{ V}$, $R1 = 2 \text{ k}\Omega$, $R2 = 3 \text{ k}\Omega$, DAC1 = 0 V, DAC2 = 0 V, GAIN1 = two times, GAIN2 = four times, and VF = 0.3 V in *Formula 17*, *Formula 17* is expressed as follows:

$$Acceleration = \frac{\left(\frac{AD_conversion_value}{2^{12}-1} \times 3.3 \times \frac{2k+3k}{3k}\right) + 1.2}{8.8 \times 10^{-3}}$$
 ... Formula 18

Note The set values used in *Formula 18* are reference values. The user needs to evaluate the system to determine the actual values.

5.5 LCD Module

This section describes the contents displayed in the LCD module (ACM0802C).

(1) Specifications of the LCD module

■ Model name: ACM0802C-NLW-BBH
 ■ Manufacturer: AZ Displays, Inc.
 ■ Number of displayed characters: 8 characters × 2 lines

■ Power supply voltage: 5 V

(2) Displaying the calculation result (physical quantity)

Figure 5.7 shows how the calculation result is displayed on the LCD module. The calculation result is displayed on the upper line. The number is displayed to the first decimal place, justified to the left. The unit is displayed as G. The averaged A/D conversion value is displayed in three-digit hexadecimal on the bottom line.

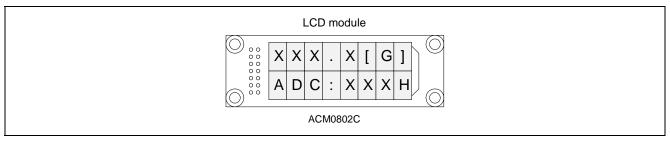


Figure 5.7 LCD Module Display Format

(3) Updating the calculation result (physical quantity)

How the calculation result (acceleration) is updated and cleared on the LCD module is shown below.

- A/D conversion of the output from the shock sensor is executed at 1 ms intervals.
- If an A/D conversion value larger than the one displayed on the LCD is detected, the CPU acquires the results of the subsequent 10 A/D conversions, calculates the averaged value of the 10 A/D conversion results, calculates the physical quantity (acceleration), and then updates the LCD module. At the same time, the averaged A/D conversion value is also displayed on the LCD module.
- If the LCD display is not updated for 5 seconds, the physical quantity (acceleration) and the averaged A/D conversion value displayed on the LCD are cleared:

6. Analog Block of RL78/G1E (R5F10FMx)

This section describes the functions used in the analog block of the RL78/G1E (R5F10FMx).

6.1 Overview of Analog Block of RL78/G1E (R5F10FMx)

The analog block of the RL78/G1E (R5F10FMx) has on-chip circuits such as configurable amplifiers, a gain adjustment amplifier, a filter circuit, D/A converters, and a temperature sensor, allowing the R5F10FMx to be used as an analog front-end circuit for processing very small sensor signals.

The block diagram of the analog block of the RL78/G1E (R5F10FMx) is shown below. The blocks described in the following sections are shaded.

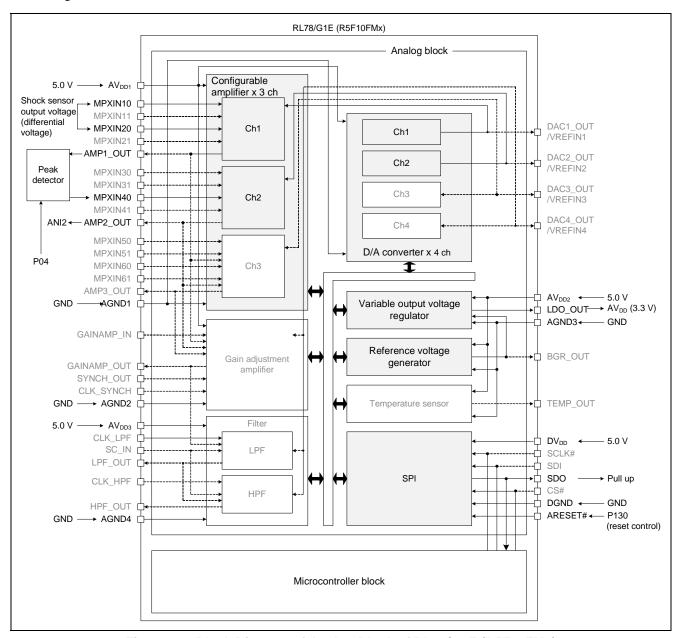


Figure 6.1 Block Diagram of Analog Block of RL78/G1E (R5F10FMx)

6.2 Functions of Analog Block of RL78/G1E (R5F10FMx)

This section describes the analog block of the RL78/G1E (R5F10FMx) used in this application note in detail.

6.2.1 Configurable amplifier

In this application note, configurable amplifier Ch1 is used as a differential amplifier and configurable amplifier Ch2 is used as a non-inverting amplifier.

(1) Overview of configurable amplifier features

The RL78/G1E (R5F10FMx) has three on-chip configurable amplifier channels.

By specifying settings in the SPI control registers, the configurable amplifiers can be used to realize the following features:

Table 6.1 Overview of Configurable Amplifier

Description	Overview
Non-inverting	The gain can be specified between 10 dB and 40 dB in 18 steps.
amplifier	Four operating modes are available.
	Includes a power-off feature.
	* Single-channel operation
Inverting amplifier	The gain can be specified between 6 dB and 40 dB in 18 steps of 2 dB each.
	Four operating modes are available.
	Includes a power-off feature.
	* Single-channel operation
Differential	The gain can be specified between 6 dB and 40 dB in 18 steps of 2 dB each.
amplifier	Four operating modes are available.
	Includes a power-off feature.
	* Single-channel operation
Transimpedance	• The feedback resistance can be specified between 20 k Ω and 640 k Ω in 6 steps.
amplifier	Four operating modes are available.
	Includes a low-current mode.
	* Single-channel operation
Instrumentation	The gain can be specified between 20 dB and 54 dB in 18 steps of 2 dB each.
amplifier	Four operating modes are available.
	Includes a power-off feature.
	* On-chip configurable amplifier × 3 ch

(2) Settings specified when using configurable amplifier Ch1 as a differential amplifier

The settings specified when using configurable amplifier Ch1 as a differential amplifier are as follows.

- Connect the voltage (differential voltage) output from the shock sensor (PKGS-00LD-R) to the inverted input source (MPXIN10) and the non-inverted input source (MPXIN20) of configurable amplifier Ch1.
- Specify the settings as shown below when using configurable amplifier Ch1 as a differential amplifier (gain: 6 dB).
 - <1> Set SW11 to 0, SW12 to 0, and SW13 to 1 in configuration register 1 (CONFIG1).
 - <2> Set MPX11 to 0 and MPX10 to 0 in MPX setting register 1 (MPX1) to specify the MPXIN10 pin as the source of inverted input to configurable amplifier Ch1.
 - <3> Set MPX21 to 0 and MPX20 to 0 in MPX setting register 1 (MPX1) to specify the MPXIN20 pin as the source of non-inverted input to configurable amplifier Ch1.
 - <4> Set CC1 to 0 and CC0 to 0 in the AMP operation mode control register (AOMC) to specify high-speed mode as the operating mode of configurable amplifier channels Ch1 to Ch3.
 - <5> Set gain control register 1 (GC1) to 00H to specify 6 dB as the gain (Typ.) of configurable amplifier Ch1 (used as a differential amplifier).
 - <6> Set SW01 to 1 in configuration register 2 (CONFIG2).
 - <7> Set AMP1OF to 1 in power control register 1 (PC1) to start operation of configurable amplifier Ch1 (used as a differential amplifier).

Figure 6.2 shows a block diagram of configurable amplifier Ch1 when used as a differential amplifier.

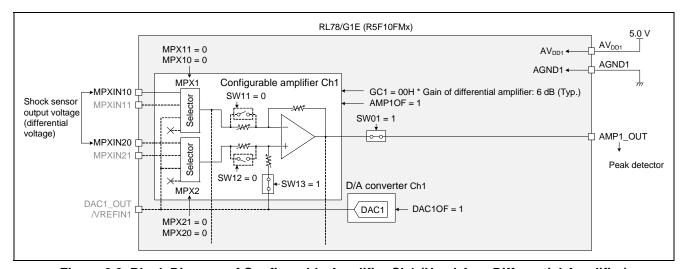


Figure 6.2 Block Diagram of Configurable Amplifier Ch1 (Used As a Differential Amplifier)

(3) Settings specified when using configurable amplifier Ch2 as a non-inverting amplifier

The settings specified when using configurable amplifier Ch2 as a non-inverting amplifier are as follows.

- Connect the voltage output from the peak detector to the non-inverted input source (MPXIN40) of configurable amplifier Ch2.
- Specify the settings as shown below when using configurable amplifier Ch2 as a non-inverting amplifier (gain: 12 dB).
 - <1> Set SW21 to 0, SW22 to 1, and SW23 to 0 in configuration register 1 (CONFIG1).
 - <2> Set MPX31 to 1 and MPX30 to 0 in MPX setting register 1 (MPX1) to specify the D/A converter Ch2 output signal or the VREFIN2 pin as the source of inverted input to configurable amplifier Ch2.
 - <3> Set MPX41 to 0 and MPX40 to 0 in MPX setting register 1 (MPX1) to specify the MPXIN40 pin as the source of non-inverted input to configurable amplifier Ch2.
 - <4> Set CC1 to 0 and CC0 to 0 in the AMP operation mode control register (AOMC) to specify high-speed mode as the operating mode of configurable amplifier channels Ch1 to Ch3.
 - <5> Set gain control register 2 (GC2) to 02H to specify 12 dB as the gain (Typ.) of configurable amplifier Ch2 (used as a non-inverting amplifier).
 - <6> Set SW02 to 1 in configuration register 2 (CONFIG2).
 - <7> Set AMP2OF to 1 in power control register 1 (PC1) to start operation of configurable amplifier Ch2 (used as a non-inverting amplifier).

Figure 6.3 shows a block diagram of configurable amplifier Ch2 when used as a non-inverting amplifier.

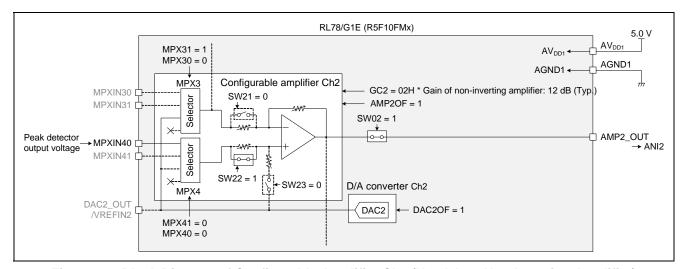


Figure 6.3 Block Diagram of Configurable Amplifier Ch2 (Used As a Non-Inverting Amplifier)

6.2.2 Reference voltage generator and variable output voltage regulator

The RL78/G1E (R5F10FMx) has an on-chip reference voltage generator channel and variable output voltage regulator channel. The variable output voltage regulator is a series regulator that generates 3.3 V (default) from a supplied voltage of 5 V. In this application note, the voltage output from the variable output voltage regulator (LDO_OUT) is connected to the AV_{DD} pin in the RL78/G1E (R5F10FMx) and used as a voltage of 3.3 V supplied to the A/D converter.

(1) Overview of variable output voltage regulator features

■ Output voltage range: 2.0 to 3.3 V (Typ.)

Output current: 15 mA (Max.)

■ Includes a power-off feature.

(2) Overview of reference voltage generator features

■ Output reference voltage: 1.21 V (Typ.)

■ Includes a power-off feature.

(3) Settings specified for reference voltage generator and variable output voltage regulator

Specify the settings for the reference voltage generator and variable output voltage regulator as shown below.

- <1> Set the LDO control register (LDOC) to 0DH to specify 3.3 V as the voltage output from the variable output voltage regulator.
- <2> Set LDOOF to 1 in power control register 2 (PC2) to start operation of the reference voltage generator and variable output voltage regulator.

Figure 6.4 shows a block diagram of the reference voltage generator and variable output voltage regulator.

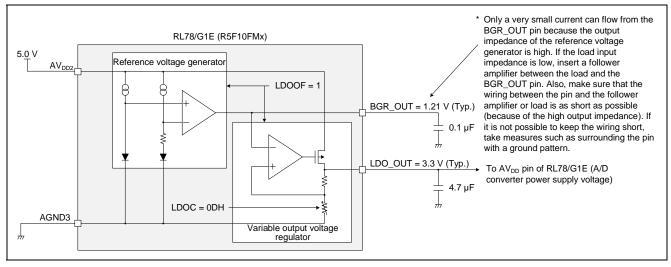


Figure 6.4 Block Diagram of Reference Voltage Generator and Variable Output Voltage Regulator

(4) Notes on using reference voltage generator

Observe the following points when using the reference voltage generator:

Only a very small current can flow from the BGR_OUT pin because the output impedance of the reference voltage generator is high. If the load input impedance is low, insert a follower amplifier between the load and the BGR_OUT pin. Also, make sure that the wiring between the pin and the follower amplifier or load is as short as possible. If it is not possible to keep the wiring short, take measures such as surrounding the pin with a ground pattern.

6.2.3 D/A converter

The RL78/G1E (R5F10FMx) has four on-chip 8-bit D/A converter channels. In this application note, D/A converter Ch1 is used to generate a bias voltage for configurable amplifier Ch1 (used as a differential amplifier) and D/A converter Ch2 is used to generate a bias voltage for configurable amplifier Ch2 (used as a non-inverting amplifier).

(1) Overview of D/A converter features

- \blacksquare 8-bit resolution \times 4 ch
- R-2R ladder method
- Analog output voltage: (reference voltage upper limit reference voltage lower limit) \times 2 \times m/255 + 2 \times reference voltage lower limit
 - (m: Value set to DACnC register)
- Controls the reference voltage for the configurable amplifiers, gain adjustment amplifier, high-pass filter, and low-pass filter
- Includes a power-off feature.
- Conversion speed (settling time): 100 μs (Max.)
- Voltage resolution: 19.608 mV
 - * Reference voltage upper limit = $AV_{DD1} \times 5/10$
 - * Reference voltage lower limit = AGND1
 - * $AV_{DD1} = 5.0 \text{ V}$

(2) Settings specified for D/A converter

- In this application note, the reference voltage upper limit for the D/A converter (VRT) is set to $AV_{DD1} \times 5/10$, and the reference voltage lower limit for the D/A converter (VRB) is set to AGND1. The voltage output from D/A converter channels Ch1 to Ch4 therefore ranges from AGND1 to AV_{DD1} (0 to 5 V).
- Specify the settings for the D/A converter as shown below.
 - <1> Set VRT1 to 0 and VRT0 to 0 in the DAC reference voltage control register (DACRC) to specify " $AV_{DD1} \times 5/10$ " as the reference voltage upper limit (VRT) for D/A converter channels Ch1 to Ch4.
 - <2> Set VRB1 to 0 and VRB0 to 0 in the DAC reference voltage control register (DACRC) to specify AGND1 as the reference voltage lower limit (VRB) for D/A converter channels Ch1 to Ch4.
 - <3> Specify the output analog voltage value by using DAC control registers 1 to 4 (DAC1C to DAC4C) corresponding to the D/A converter used.
 - * In this application note, D/A converter Ch1 is used to generate a bias voltage for configurable amplifier Ch1 (used as a differential amplifier). Set the DAC1C register to 00H to specify 0 V as the voltage output from the DAC1_OUT pin. (Note that the value set to the DAC1C register is a reference value. The user needs to evaluate the system to determine the actual values.)
 - * In this application note, D/A converter Ch2 is used to generate a bias voltage for configurable amplifier Ch2 (used as a non-inverting amplifier). Set the DAC2C register to 00H to specify 0 V as the voltage output from the DAC2_OUT pin. (Note that the value set to the DAC2C register is a reference value. The user needs to evaluate the system to determine the actual values.)
 - <4> Set DAC2OF and DAC1OF to 1 in power control register 1 (PC1) to start operation of this channel. Set all the other bits to 0. (DAC4OF = 0, DAC3OF = 0, DAC2OF = 1, and DAC1OF = 1.)

RL78/G1E (R5F10FMx) 5.0 V AV_{DD} D/A converter Ch1 DAC1 OUT 8-bit $AV_{DD1} \times 5/10$ /VREFIN1 DAC1 $AV_{DD1} \times 4/10$ $AV_{DD1} \times 3/10$ DAC1OF = 1 Reference voltage upper limit (VRT) generator DAC1C = 00HVRT1 = 0D/A converter Ch2 VRT0 = 0DAC2_OUT 8-bit /VREFIN2 DAC2 $AV_{DD1} \times 2/10$ AGND1 Selector $AV_{DD1} \times 1/10$ DAC2OF = 1AGND1 DAC2C = 00HReference voltage lower limit (VRB) generator VRB1 = 0VRB0 = 0Configurable amplifier Ch1 0 V (used as a differential amplifier) Bias voltage when using a differential amplifier 0 V Configurable amplifier Ch2 (used as a non-inverting amplifier) Bias voltage when using a non-inverting amplifier

Figure 6.5 shows a block diagram of D/A converter channels Ch1 and Ch2.

Figure 6.5 Block Diagram of D/A Converter

(3) Notes on using the D/A converter

Observe the following points when using the D/A converter:

- Only a very small current can flow from the DACn_OUT pin because the output impedance of the D/A converter is high. If the load input impedance is low, insert a follower amplifier between the load and the DACn_OUT pin. Also, make sure that the wiring between the pin and the follower amplifier or load is as short as possible. If it is not possible to keep the wiring short, take measures such as surrounding the pin with a ground pattern.
- If inputting an external reference power supply to the VREFINn pin, be sure to set the DACnOF bit to 0.

Remark: n = 1 to 4

6.2.4 SPI

The SPI is used to allow control from external devices by using clocked communication via four lines: a serial clock line (SCLK#), two serial data lines (SDI and SDO), and a slave selection input line (CS#).

(1) Overview of SPI features

- Data transmission/reception:
 - 16-bit data unit
 - MSB first
- The SPI pins SCLK#, SDI, and SDO, which are located in the analog block of the RL78/G1E (R5F10FMx), are connected to the corresponding pins in the 3-wire serial I/O function block (CSI21) of channel 1 of serial array unit 1 in the microcontroller block inside the package. The CS# pin is connected to the P73 pin in the microcontroller block inside the package.
- The RL78/G1E (R5F10FMx) has an on-chip analog reset feature. A reset can be generated in the following two ways:
 - By inputting an external reset signal to the ARESET# pin
 - By generating an internal reset by writing 1 to the RESET bit of the reset control register (RC)
- In this application note, the ARESET# pin in the RL78/G1E (R5F10FMx) is connected to the P130 pin in the microcontroller block to control the analog reset feature.

Figure 6.6 shows the pin connections of the SPI in the RL78/G1E (R5F10FMx).

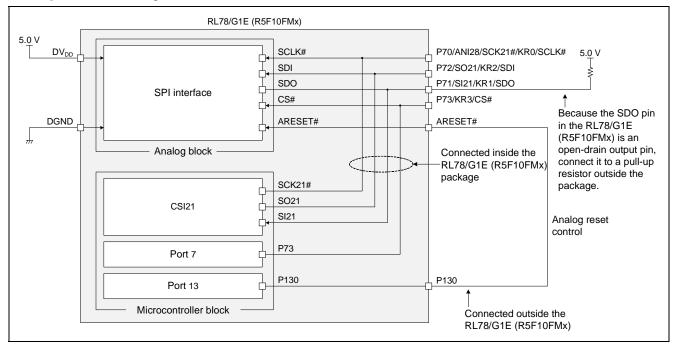


Figure 6.6 SPI Configuration Example

(2) SPI communication

The SPI transmits and receives data in 16-bit units. Data can be transmitted and received when CS# is low. Data is transmitted one bit at a time in synchronization with the falling edge of the serial clock, and is received one bit at a time in synchronization with the rising edge of the serial clock. When the R/W bit is 1, data is written to the SPI control register in accordance with the address/data setting when the rising edge of the 16th SCLK# signal is detected after the fall of CS#. When the R/W bit is 0, the data is output from the register in accordance with the address/data setting, in synchronization with the 9th and later falling edges of SCLK# following the fall of CS#.

In this application note, the SPI in the analog block of the RL78/G1E (R5F10FMx) and CSI21 in the microcontroller block, to which the SPI is connected inside the RL78/G1E (R5F10FMx) chip, are used to perform SPI communication. A 32 MHz clock generated by the high-speed on-chip oscillator is used as the main system clock for the RL78/G1E (R5F10FMx), and 1 MHz is selected as the operating clock for SPI communication. The slave select input (CS#) pin for the SPI is controlled by using the P73 pin in the RL78/G1E (R5F10FMx).

Figure 6.7 shows the SPI communication timing.

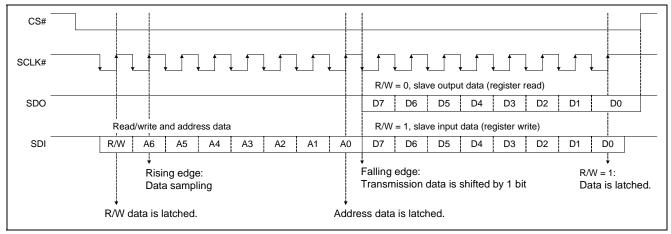


Figure 6.7 SPI Communication Timing

(3) SPI control registers

Table 6.2 shows the SPI control registers.

Table 6.2 SPI Control Registers

Address	SPI Contro	Register	R/W	After Reset
00H	CONFIG1 Configuration register 1		R/W	00H
01H	CONFIG2	Configuration register 2	R/W	00H
03H	MPX1	MPX setting register 1	R/W	00H
04H	MPX2	MPX setting register 2	R/W	H00
05H	MPX3	MPX setting register 3	R/W	00H
06H	GC1	Gain control register 1	R/W	00H
07H	GC2	Gain control register 2	R/W	00H
08H	GC3	Gain control register 3	R/W	00H
09H	AOMC	AMP operation mode control register	R/W	00H
0AH	GC4	Gain control register 4	R/W	00H
0BH	LDOC	LDO control register	R/W	0DH
0CH	DACRC	DAC reference voltage control register	R/W	00H
0DH	DAC1C	DAC control register 1	R/W	80H
0EH	DAC2C	DAC control register 2	R/W	80H
0FH	DAC3C	DAC control register 3	R/W	80H
10H	DAC4C	DAC control register 4	R/W	80H
11H	PC1	Power control register 1	R/W	00H
12H			R/W	00H
13H	RC	Reset control register	R/W	00H ^{Note}

Note When generating an internal reset by writing 1 to the RESET bit of the reset control register, the reset control register is not initialized.

(4) Analog reset feature

The RL78/G1E (R5F10FMx) has an on-chip analog reset feature. A reset can be generated in the following two ways:

- By inputting an external reset signal to the ARESET# pin
- By generating an internal reset by writing 1 to the RESET bit of the reset control register (RC)

There are no functional differences between an external and an internal reset: both types serve to initialize Note the SPI control registers.

If a low-level signal is input to the ARESET# pin or if 1 is written to the RESET bit of the reset control register (RC), the analog circuits enter the statuses shown in **Table 6.3**. The statuses of the SPI control registers after a reset has been acknowledged are shown in **Table 6.4**.

A reset is generated by inputting a low-level signal to the ARESET# pin. The reset is subsequently canceled by inputting a high-level signal to this pin.

When generating an internal reset by writing 1 to the RESET bit of the reset control register, the reset occurs^{Note} after 1 is written to the RESET bit, and is subsequently canceled by writing 0 to the same bit.

In this application note, the ARESET# pin in the RL78/G1E (R5F10FMx) is connected to the P130 pin in the microcontroller block to control the analog reset feature.

Note When generating an internal reset by writing 1 to the RESET bit of the reset control register, the reset control register is not initialized.

Caution When generating an external reset, input a low-level signal to the ARESET# pin for at least 10 µs.

Table 6.3 Statuses During an Analog Reset Period

Function Block	By Inputting an External Reset Signal to the ARESET# Pin	By Generating an Internal Reset by Writing 1 to the RESET Bit of the Reset Control Register (RC)			
Configurable amplifier	Operation	on stops.			
Gain adjustment amplifier	Operation	Operation stops.			
D/A converter	Operation stops.				
Low-pass filter	Operation	on stops.			
High-pass filter	Operation	on stops.			
Temperature sensor	Operation stops.				
Variable output voltage regulator	Operation stops.				
Reference voltage generator	Operation stops.				
SPI	Operation stops.	Operation enabled			

Table 6.4 Statuses of SPI Control Registers After an Analog Reset Is Acknowledged

Address	SPI Contro	I Register	Status After an Analog Reset Is Acknowledged
00H	CONFIG1	Configuration register 1	00H
01H	CONFIG2	Configuration register 2	00H
03H	MPX1	MPX setting register 1	00H
04H	MPX2	MPX setting register 2	00H
05H	MPX3	MPX setting register 3	00H
06H	GC1	Gain control register 1	00H
07H	GC2	Gain control register 2	00H
08H	GC3	Gain control register 3	00H
09H	AOMC	AMP operation mode control register	00H
0AH	GC4	Gain control register 4	00H
0BH	LDOC	LDO control register	0DH
0CH	DACRC	DAC reference voltage control register	00H
0DH	DAC1C	DAC control register 1	80H
0EH	DAC2C	DAC control register 2	80H
0FH	DAC3C	DAC control register 3	80H
10H	DAC4C	DAC control register 4	80H
11H	PC1	Power control register 1	00H
12H	PC2	Power control register 2	00H
13H	RC	Reset control register	00H ^{Note}

Note When generating an internal reset by writing 1 to the RESET bit of the reset control register, the reset control register is not initialized.

6.3 Settings of SPI Control Registers of RL78/G1E (R5F10FMx)

This section describes the settings of the SPI control registers used in this application note. This section omits descriptions of the SPI control registers not used in this application note. (They are used with their default values.) For details, see the *RL78/G1E Hardware User's Manual*.

Caution For how to specify the register settings, see the RL78/G1E Hardware User's Manual.

(1) Configuration register 1 (CONFIG1)

This register is used to turn on or off the switches of configurable amplifier channels Ch1 and Ch2.

Address: 00H	After res	et: 00H	R/W	Set value: 12H					
Symbol	7	6	5	4	3	2	1	0	
CONFIG1	0	SW11	SW12	SW13	0	SW21	SW22	SW23	Ì
Set value	0	0	0	1	0	0	1	0	1

SW11	Control of SW11
0	Turn off SW11.
1	Turn on SW11.

SW12	Control of SW12
0	Turn off SW12.
1	Turn on SW12.

SW13	Control of SW13
0	Turn off SW13.
1	Turn on SW13.

SW21	Control of SW21
0	Turn off SW21.
1	Turn on SW21.

ĺ	SW22	Control of SW22
ſ	0	Turn off SW22.
	1	Turn on SW22.

SW23	Control of SW23
0	Turn off SW23.
1	Turn on SW23.

(2) Configuration register 2 (CONFIG2)

This register is used to turn on or off the switches of configurable amplifier channels Ch1 and Ch2.

Address: 01H	After res	set: 00H	R/W	Set	value: 06H			
Symbol	7	6	5	4	3	2	1	0
CONFIG2	0	SW31	SW32	SW33	0	SW02	SW01	SW00
Set value	0	0	0	0	0	1	1	0

ŀ	1	Turn on SW02.
Ī	0	Turn off SW02.
	SW02	Control of SW02

1	Turn on SW01.
0	Turn off SW01.
SW01	Control of SW01

(3) MPX setting register 1 (MPX1)

This register is used to control MPX1, MPX2, MPX3, and MPX4.

This register is used to select the signal input to configurable amplifier channels Ch1 and Ch2.

Address: 03H After reset: 00H R/W Set value: 08H 4 Symbol 7 5 3 2 1 0 MPX1 MPX11 MPX10 MPX21 MPX20 MPX31 MPX30 MPX41 MPX40 Set value

MPX11	MPX10	Source of configurable amplifier Ch1 inverted input	
0	0	MPXIN10 pin	
0	1	MPXIN11 pin	
1	0	D/A converter Ch1 output signal or VREFIN1 pin	
1	1	Leave open	

MPX21	MPX20	Source of configurable amplifier Ch1 non-inverted input
0	0	MPXIN20 pin
0	1	MPXIN21 pin
1	0	D/A converter Ch1 output signal or VREFIN1 pin
1	1	Leave open

MPX31	MPX30	Source of configurable amplifier Ch2 inverted input
0	0	MPXIN30 pin
0	1	MPXIN31 pin
1	0	D/A converter Ch2 output signal or VREFIN2 pin
1	1	Leave open

MPX41	MPX40	Source of configurable amplifier Ch2 non-inverted input		
0	0	MPXIN40 pin		
0	1	MPXIN41 pin		
1	0	D/A converter Ch2 output signal or VREFIN2 pin		
1	1	Leave open		

(4) Gain control register 1 (GC1)

This register is used to specify the gain and feedback resistance of configurable amplifier Ch1.

The value to specify depends on the configuration of configurable amplifier Ch1. In this application note, the configurable amplifier is used as a differential amplifier.

Address: 06H	After res	After reset: 00H R/W			value: 00H			
Symbol	7	6	5	4	3	2	1	0
GC1	0	0	0	AMPG14	AMPG13	AMPG12	AMPG11	AMPG10
Set value	0	0	0	0	0	0	0	0

AMPG14	AMPG13	AMPG12	AMPG11	AMPG10	Gain of configurable amplifier Ch1 used as differential amplifier (Typ.)
0	0	0	0	0	6 dB
0	0	0	0	1	8 dB
0	0	0	1	0	10 dB
0	0	0	1	1	12 dB
0	0	1	0	0	14 dB
0	0	1	0	1	16 dB
0	0	1	1	0	18 dB
0	0	1	1	1	20 dB
0	1	0	0	0	22 dB
0	1	0	0	1	24 dB
0	1	0	1	0	26 dB
0	1	0	1	1	28 dB
0	1	1	0	0	30 dB
0	1	1	0	1	32 dB
0	1	1	1	0	34 dB
0	1	1	1	1	36 dB
1	0	0	0	0	38 dB
1	0	0	0	1	40 dB
	Ot	her than abo	ve		Setting prohibited

(5) Gain control register 2 (GC2)

This register is used to specify the gain and feedback resistance of configurable amplifier Ch2.

The value to specify depends on the configuration of configurable amplifier Ch2. In this application note, the configurable amplifier is used as a non-inverting amplifier.

Address: 07H	After res	After reset: 00H R/W			value: 02H			
Symbol	7	6	5	4	3	2	1	0
GC2	0	0	0	AMPG24	AMPG23	AMPG22	AMPG21	AMPG20
Set value	0	0	0	0	0	0	1	0

AMPG24	AMPG23	AMPG22	AMPG21	AMPG20	Gain of configurable amplifier Ch used as non-inverting amplifier (Typ.)		
0	0	0	0	0	10 dB		
0	0	0	0	1	11 dB		
0	0	0	1	0	12 dB		
0	0	0	1	1	14 dB		
0	0	1	0	0	16 dB		
0	0	1	0	1	17 dB		
0	0	1	1	0	19 dB		
0	0	1	1	1	21 dB		
0	1	0	0	0	23 dB		
0	1	0	0	1	25 dB		
0	1	0	1	0	26 dB		
0	1	0	1	1	28 dB		
0	1	1	0	0	30 dB		
0	1	1	0	1	32 dB		
0	1	1	1	0	34 dB		
0	1	1	1	1	36 dB		
1	0	0	0	0	38 dB		
1	0	0	0	1	40 dB		
	Ot	her than abo	ve		Setting prohibited		

(6) AMP operation mode control register (AOMC)

This register is used to specify the operating mode of configurable amplifier channels Ch1 to Ch3.

Address: 09H	After res	set: 00H	R/W	Set	value: 00H			
Symbol	7	6	5	4	3	2	1	0
AOMC	0	0	0	0	0	0	CC1	CC0
Set value	0	0	0	0	0	0	0	0

CC1	CC0	Operating mode of configurable amplifier channels Ch1 to Ch3
0	0	High-speed mode
0	1	Mid-speed mode 2
1	0	Mid-speed mode 1
1	1	Low-speed mode

(7) LDO control register (LDOC)

This register is used to specify the output voltage of the variable output voltage regulator.

Address: 0BH	After res	set: 0DH	R/W	Set	value: 0DH			
Symbol	7	6	5	4	3	2	1	0
LDOC	0	0	0	0	LDO3	LDO2	LDO1	LDO0
Set value	0	0	0	0	1	1	0	1

LDO3	LDO2	LDO1	LDO0	Output voltage of variable output voltage regulator (Typ.)
0	0	0	0	2.0 V
0	0	0	1	2.1 V
0	0	1	0	2.2 V
0	0	1	1	2.3 V
0	1	0	0	2.4 V
0	1	0	1	2.5 V
0	1	1	0	2.6 V
0	1	1	1	2.7 V
1	0	0	0	2.8 V
1	0	0	1	2.9 V
1	0	1	0	3.0 V
1	0	1	1	3.1 V
1	1	0	0	3.2 V
1	1	0	1	3.3 V
	Other that	an above		Setting prohibited

(8) DAC reference voltage control register (DACRC)

This register is used to specify the upper (VRT) and lower (VRB) limits of the reference voltage for D/A converter channels Ch1 to Ch4.

When selecting the upper limit of the reference voltage, use bits 3 and 2. When selecting the lower limit of the reference voltage, use bits 1 and 0.

Address: 0CH	H After res	set: 00H	R/W	Set	value: 00H			
Symbol	7	6	5	4	3	2	1	0
DACRC	0	0	0	0	VRT1	VRT0	VRB1	VRB0
Set value	0	0	0	0	0	0	0	0

VRT1	VRT0	Upper limit of reference voltage (Typ.)
0	0	AV _{DD1} × 5/10
0	1	AV _{DD1} × 4/10
1	0	AV _{DD1} × 3/10
1	1	AV _{DD1} × 5/10

VRB1	VRB0	Upper limit of reference voltage (Typ.)
0	0	AGND1
0	1	AV _{DD1} × 1/10
1	0	$AV_{DD1} \times 2/10$
1	1	AGND1

(9) DAC control register 1 (DAC1C)

This register is used to specify the analog voltage to be output to the DAC1_OUT pin.

The DAC1_OUT output signal is used to generate a bias voltage for configurable amplifier Ch1 (used as a differential amplifier).

Address: 0DH After reset: 80H			R/W	Set	value: 19H			
Symbol	7	6	5	4	3	2	1	0
DAC1C	DAC17	DAC16	DAC15	DAC14	DAC13	DAC12	DAC11	DAC10
Set value	0	0	0	1	1	0	0	1

■ DAC1_OUT output voltage

= ((reference voltage upper limit – reference voltage lower limit) \times 2 \times m/255) + 2 \times reference voltage lower limit

$$= ((AV_{DD1} \times 5/10 - AGND1) \times 2 \times 0/255) + 2 \times AGND1$$

$$= ((2.5 \text{ V} - 0 \text{ V}) \times 2 \times 0/255) + 2 \times 0 \text{ V}$$

=0 V

* $AV_{DD1} = 5.0 \text{ V}$

* AGND1 = 0 V

* m (DAC1C register value) = 0 (00H)

■ The value set to the DAC1C register is a reference value. The user needs to evaluate the system to determine the actual values.

(10) DAC control register 2 (DAC2C)

This register is used to specify the analog voltage to be output to the DAC2_OUT pin.

The DAC2_OUT output signal is used to generate a bias voltage for configurable amplifier Ch2 (used as a non-inverting amplifier).

Address: 0E	H After res	set: 80H	R/W	Set	value: 19H			
Symbol	7	6	5	4	3	2	1	0
DAC2C	DAC27	DAC26	DAC25	DAC24	DAC23	DAC22	DAC21	DAC20
Set value	0	0	0	1	1	0	0	1

- DAC2_OUT output voltage
 - $= ((reference\ voltage\ lower\ limit) \times 2 \times m/255) + 2 \times reference\ voltage\ lower\ limit)$
 - $= ((AV_{DD1} \times 5/10 AGND1) \times 2 \times 0/255) + 2 \times AGND1$
 - $= ((2.5 \text{ V} 0 \text{ V}) \times 2 \times 0/255) + 2 \times 0 \text{ V}$
 - = 0 V
 - * $AV_{DD1} = 5.0 \text{ V}$
 - * AGND1 = 0 V
 - * m (DAC2C register value) = 0 (00H)
- The value set to the DAC2C register is a reference value. The user needs to evaluate the system to determine the actual values.

(11) Power control register 1 (PC1)

This register is used to enable or disable operation of the configurable amplifier and D/A converter. Use this register to stop unused functions to reduce power consumption and noise.

When using one of D/A converter channels Ch1 to Ch4, be sure to set the control bit that corresponds to the channel (bits 7 to 4) to 1.

When using one of configurable amplifier channels Ch1 to Ch3, be sure to set the control bit that corresponds to the channel (bits 2 to 0) to 1.

Address: 11	H After res	et: 00H	R/W	Set ^s	value: 33H			
Symbol	7	6	5	4	3	2	1	0
PC1	DAC4OF	DAC3OF	DAC2OF	DAC10F	0	AMP3OF	AMP2OF	AMP1OF
Set value	0	0	1	1	0	0	1	1

DAC4OF	Operation of D/A converter Ch4
0	Stop operation of D/A converter Ch4.
1	Enable operation of D/A converter Ch4.

DAC3OF	Operation of D/A converter Ch3
0	Stop operation of D/A converter Ch3.
1	Enable operation of D/A converter Ch3.

DAC2OF	Operation of D/A converter Ch2
0	Stop operation of D/A converter Ch2.
1	Enable operation of D/A converter Ch2.

1	Enable operation of D/A converter Ch1.
0	Stop operation of D/A converter Ch1.
DAC10F	Operation of D/A converter Ch1

AMP3OF	Operation of configurable amplifier Ch3
0	Stop operation of configurable amplifier Ch3.
1	Enable operation of configurable amplifier Ch3.

AMP2OF	Operation of configurable amplifier Ch2
0	Stop operation of configurable amplifier Ch2.
1	Enable operation of configurable amplifier Ch2.

AMP1OF	Operation of configurable amplifier Ch1
0	Stop operation of configurable amplifier Ch1.
1	Enable operation of configurable amplifier Ch1.

(12) Power control register 2 (PC2)

This register is used to enable or disable operation of the gain adjustment amplifier, the low-pass filter, the high-pass filter, the variable output voltage regulator, the reference voltage generator, and the temperature sensor. Use this register to stop unused functions to reduce power consumption and noise.

When using the gain adjustment amplifier, be sure to set bit 4 to 1.

When using the low-pass filter, be sure to set bit 3 to 1.

When using the high-pass filter, be sure to set bit 2 to 1.

When using the variable output voltage regulator and reference voltage generator, be sure to set bit 1 to 1.

When selecting the signal to be input to the temperature sensor, be sure to set bit 0 to 1.

Address: 12H	After res	set: 00H	R/W Set value: 02H					
Symbol	7	6	5	4	3	2	1	0
PC2	0	0	0	GAINOF	LPFOF	HPFOF	LDOOF	TEMPOF
Set value	0	0	0	0	0	0	1	0

	GAINOF	Operation of gain adjustment amplifier		
ſ	0	0 Stop operation of the gain adjustment amplifier.		
Ī	1	1 Enable operation of the gain adjustment amplifier.		

LPFOF	Operation of low-pass filter			
0	Stop operation of the low-pass filter.			
1	Enable operation of the low-pass filter.			

HPFOF	Operation of high-pass filter		
0	Stop operation of the high-pass filter.		
1	Enable operation of the high-pass filter.		

LDOOF	Operation of variable output voltage regulator and reference voltage generator		
0	Stop operation of the variable output voltage regulator and reference voltage		
	generator.		
1	Enable operation of the variable output voltage regulator and reference		
	voltage generator.		

TEMPOF	Operation of temperature sensor			
0	Stop operation of the temperature sensor.			
1	Enable operation of the temperature sensor.			

7. Microcontroller Block of RL78/G1E (R5F10FMx)

This section describes the functions and software used by the microcontroller block of the RL78/G1E (R5F10FMx).

7.1 Functions Assigned to the Microcontroller Block of the RL78/G1E (R5F10FMx)

Figure 7.1 shows the function blocks in the microcontroller block of the RL78/G1E (R5F10FMx), and **Table 7.1** shows the assigned roles.

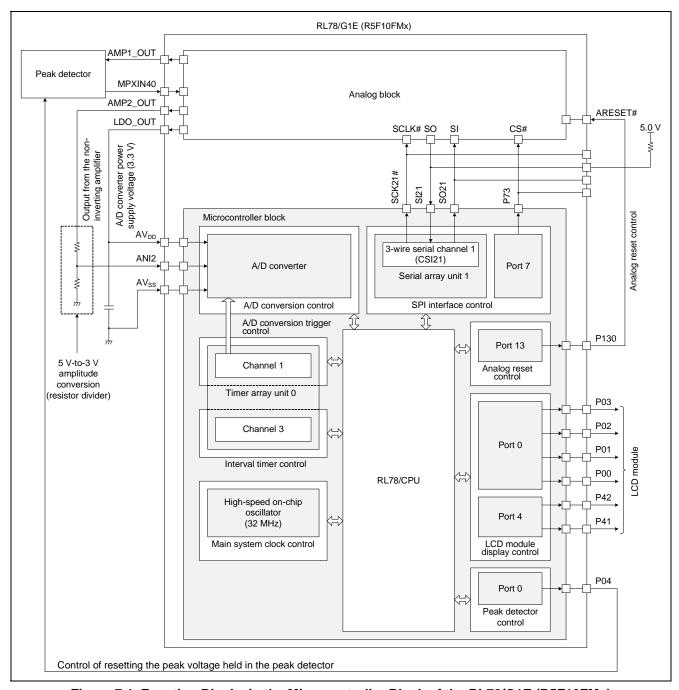


Figure 7.1 Function Blocks in the Microcontroller Block of the RL78/G1E (R5F10FMx)

Table 7.1 Functions Assigned to the Microcontroller Block of the RL78/G1E (R5F10FMx)

Functions Block	Assigned Role		
CSI21	Control SPI communication with the SPI in the analog block of the RL78/G1E		
Port 7 (P73)	(R5F10FMx).		
A/D converter	Controls A/D conversion of the voltage (AMP2_OUT) output from configurable amplifier Ch2 (used as a non-inverting amplifier), stepped down by using a resistor divider, and input to the ANI2 pin.		
Port 13 (P130)	Controls the analog reset feature.		
Timer array unit 0 (channel 1)	Controls the hardware trigger signal for the A/D converter.		
Timer array unit 0 (channel 3)	Controls the interval timer for generating the wait time used by software.		
Port 0 (P00 to P03)	Control the LCD module display		
Port 4 (P41, P42)	Control the LCD module display.		
Port 0 (P04)	Controls resetting of the peak voltage held by the peak detector.		
High-speed on-chip oscillator	Generates the 32 MHz clock selected as the main system clock.		

7.2 Functions of the Microcontroller Block of the RL78/G1E (R5F10FMx)

7.2.1 High-speed on-chip oscillator (clock generator)

In this application note, a 32 MHz clock generated by the high-speed on-chip oscillator (high-speed OCO) is used as the main system clock. The clock generator features are described below.

- Select 32 MHz as the high-speed on-chip oscillator frequency by using FRQSEL[3:0] of the user option byte (000C2H).
- By setting the user option byte (000C2H), after a reset period ends, the CPU starts operating on the high-speed on-chip oscillator clock ($f_{IH} = 32 \text{ MHz}$ (Typ.)). Oscillation can be stopped by executing the STOP instruction or by setting the HIOSTOP bit of the clock operation status control register (CSC).
- Select the high-speed on-chip oscillator clock ($f_{IH} = 32 \text{ MHz}$ (Typ.)) as the main system clock (f_{MAIN}) by using the MCM0 bit of the system clock control register (CKC).
- Enable clock input to timer array unit 0, serial array unit 1, and the A/D converter by using peripheral enable register 0 (PER0). In this application note, clock input to unused peripheral functions is stopped to reduce power consumption and noise.
- The high-speed on-chip oscillator frequency specified by the user option byte (000C2H) can be changed by using the high-speed on-chip oscillator frequency select register (HOCODIV). In this application note, the high-speed on-chip oscillator frequency is not changed.
- The accuracy of the high-speed on-chip oscillator can be adjusted by using the high-speed on-chip oscillator trimming register (HIOTRM). In this application note, the accuracy of the high-speed on-chip oscillator is not changed.

Figure 7.2 shows a block diagram of the clock generator incorporated in the RL78/G1E (R5F10FMx) that is used in this application note.

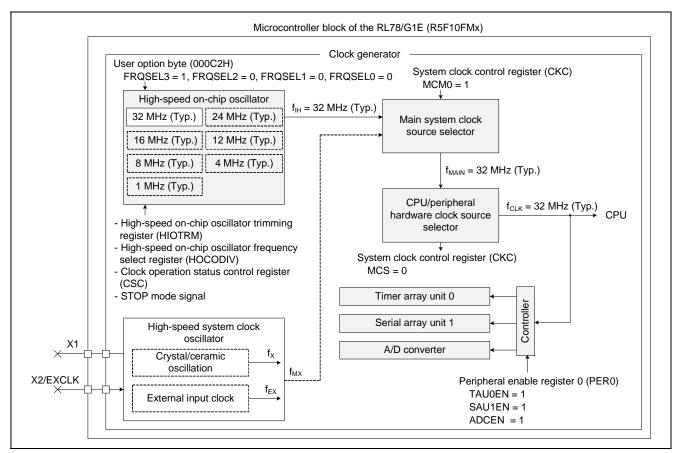


Figure 7.2 Block Diagram of the Clock Generator in the RL78/G1E (R5F10FMx)

7.2.2 SPI control

SPI communication with the SPI in the analog block of the RL78/G1E (R5F10FMx) is executed by using the 3-wire serial I/O (CSI21) of channel 1 of serial array unit 1 and the P73 pin of port 7 together.

(1) Connection with the SPI in the analog block of the RL78/G1E (R5F10FMx)

The SPI in the analog block of the RL78/G1E (R5F10FMx), CSI21 in the microcontroller block, and the P73 pin are connected in the RL78/G1E (R5F10FMx) package. Because the serial data transmission pin (SDO) in the SPI in the analog block of the RL78/G1E (R5F10FMx) is an open-drain output pin, a pull-up resistor is externally connected to the P71/SI21/KR1/SDO pin of the RL78/G1E (R5F10FMx).

Figure 7.3 shows the pin connections of the SPI of the RL78/G1E (R5F10FMx).

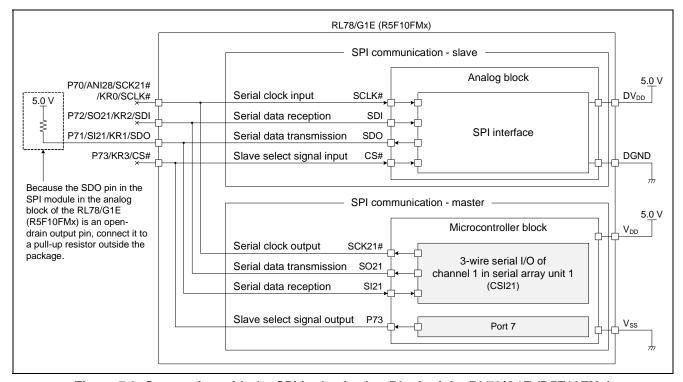


Figure 7.3 Connection with the SPI in the Analog Block of the RL78/G1E (R5F10FMx)

(2) 3-wire serial I/O (CSI21) of channel 1 of serial array unit 1 incorporated in the RL78/G1E (R5F10FMx)

In this application note, channel 1 of serial array unit 1 incorporated in the RL78/G1E (R5F10FMx) is used for 3-wire serial I/O (CSI21).

The 3-wire serial I/O function transmits and receives data in synchronization with the serial clock (SCK#) output from the master. This is a clocked communication interface that uses three communication lines: one for the serial clock (SCK#) and two for the transmission and reception of serial data (SO and SI).

In this application note, to perform SPI communication with the analog block of the RL78/G1E (R5F10FMx), CSI21 and the P73 output pin are used together as a master.

(3) Specifications of SPI communication

Channel 1 of serial array unit 1 is used for 3-wire serial I/O (CSI21) together with the output of the P73 pin to realize SPI communication with the analog block of the RL78/G1E (R5F10FMx).

Specify the CSI21 settings in accordance with SPI communication timing shown in **Figure 6.7** and the electrical specifications prescribed for the SPI in the analog block of the RL78/G1E (R5F10FMx).

Specify the settings for CSI21 as shown below.

- Supply of input clock to serial array unit 1: Enable
 - Set SAU1EN to 1 in peripheral enable register 0 (PER0) to enable supplying the input clock to channel 1 of serial array unit 1. (Enable reading from and writing to SFRs used by serial array unit 1.)
- Operating mode of channel 1 in serial array unit 1: CSI mode
 - Set MD112 to 0 and MD111 to 0 in serial mode register 11 (SMR11) to set channel 1 of serial array unit 1 to CSI mode.
- Serial data length: 8 bits
 - Set DLS111 to 1 and DLS110 to 1 in serial communication operation setting register 11 (SCR11) to specify 8 bits as the data length transferred in CSI mode.
- Data transfer order: MSB first
 - Set the DIR11 bit to 0 in serial communication operation setting register 11 (SCR11) so that data transfer in CSI mode starts from the MSB.
- Phase of data and clock signals: Type 1 (See the SPI communication timing shown in **Figure 6.7**.)
 - Set DAP11 to 0 and CKP11 to 0 in serial communication operation setting register 11 (SCR11) to specify type 1 as the phase of the data and clock signals in CSI mode.
- CSI21 operating mode (communication direction): Transmission and reception (full-duplex communication)
 - Set TXE11 to 1 and RXE11 to 1 in serial communication operation setting register 11 (SCR11) to specify transmission and reception as the CSI21 operating mode.
- CSI21 transfer clock: CSI21 outputs the transfer clock (master operation)
 - Set CCS11 to 0 in serial mode register 11 (SMR11) to specify the clock obtained by dividing the operating clock (f_{MCK}) specified by using the CKS11 bit of the SMR11 register as the CSI21 transfer clock (f_{TCLK}).
- Transfer rate: 1 Mbps
 - Select the 32 MHz clock generated by the high-speed on-chip oscillator (high-speed OCO) as the main system clock. (See 7.2.1 High-speed on-chip oscillator (clock generator).)
 - Set PRS103 to 0, PRS102 to 0, PRS101 to 0, and PRS100 to 0 in serial clock select register 1 (SPS1) to specify 32 MHz (when $f_{CLK} = 32$ MHz) as the frequency of the operating clock (CK10).
 - Set CCS11 to 0 in serial mode register 11 (SMR11) to specify the operating clock (CK10; when $f_{CLK} = 32$ MHz) specified by using the SPS1 register as the CSI21 operating clock (f_{MCK}).
 - Set the higher 7 bits (SDR11[15:9]) to 0001111B in serial data register 11 (SDR11) to specify $f_{MCK}/32$ (32 MHz/32 = 1 MHz) as the CSI21 transfer clock.

(4) SPI communication timing chart for write operations (master transmission)

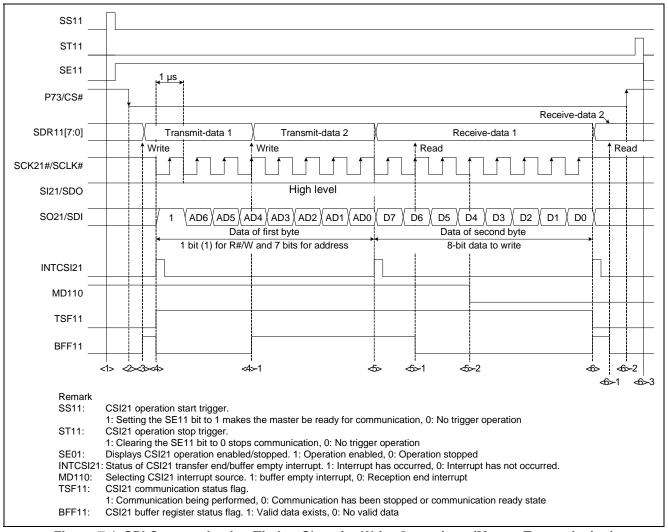


Figure 7.4 SPI Communication Timing Chart for Write Operations (Master Transmission)

- <1> SS11 is set to 1 and the master enters the communication ready state. MD110 is set to 1 to specify the buffer empty interrupt as the interrupt source.
- <2> 0 is output from the P73 pin (CS# = 0) to specify the SPI module in the analog block as the slave.
- <3> Transmit-data 1(consisting of 1 bit (1) for R#/W and 7 bits for the address) is set to SDR11[7:0].
- <4> The first interrupt occurs. (INTCSI21 = 1 (buffer empty interrupt) and the number of bytes to be transmitted > 0) <4>-1 Transmit-data 2 (8-bit data) is written to SDR11[7:0] during the interrupt routine.
- <5> The second interrupt occurs. (INTCSI21 = 1 (buffer empty interrupt) and the number of bytes to be transmitted ≤ 0)
 - <5>-1 Receive-data 1 (8-bit dummy data) is read from SDR11[7:0] during the interrupt routine.
 - <5>-2 MD110 is set to 0 to select the transfer end interrupt as the interrupt source during the interrupt routine.
- <6> The third interrupt occurs. (INTCS21 = 1 (transfer end interrupt) and MD110 = 0)
 - <6>-1 Receive-data 2 (8-bit dummy data) is read from SDR11[7:0] during the interrupt routine.
 - <6>-2 1 is output from the P73 pin (CS# = 1) to release the SPI module in the analog block as the slave.
 - <6>-3 ST11 is set to 1 and the master exits the communication ready state.

(5) SPI communication timing chart for read operations (master reception)

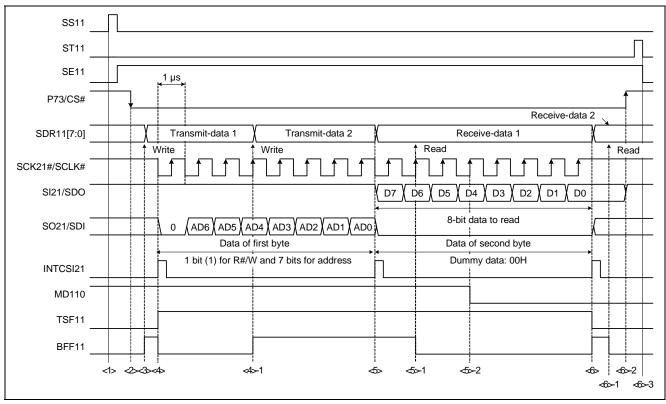


Figure 7.5 SPI Communication Timing Chart for Read Operations (Master Reception)

- <1> SS11 is set to 1 and the master enters the communication ready state. MD110 is set to 1 to specify the buffer empty interrupt as the interrupt source.
- <2> 0 is output from the P73 pin (CS# = 0) to select the SPI module in the analog block is as the slave.
- <3> Transmit-data 1 (consisting of 1 bit (0) for R#/W and 7 bits for the address) is set to SDR11[7:0].
- <4> The first interrupt occurs. (INTCSI21 = 1 (buffer empty interrupt) and the number of bytes to be transmitted > 0) <4>-1 Transmit-data 2 (8-bit dummy data 00H) is written to SDR11[7:0] during the interrupt routine.
- <5> The second interrupt occurs. (INTCSI21 = 1 (buffer empty interrupt) and the number of bytes to be transmitted ≤ 0)
 - <5>-1 Receive-data 1 (8-bit dummy data) is read from SDR11[7:0] during the interrupt routine.
 - <5>-2 MD110 is set to 0 to select the transfer end interrupt as the interrupt source during the interrupt routine.
- <6> The third interrupt occurs. (INTCS21 = 1 (transfer end interrupt) and MD110 = 0)
 - <6>-1 Receive-data 2 (8-bit data) is read from SDR11[7:0] during the interrupt routine.
 - <6>-2 1 is output from the P73 pin (CS# = 1) to release the SPI module in the analog block as the slave.
 - <6>-3 ST11 is set to 1 and the master exits the communication ready state.

Note To continuously perform write/read operations, make sure that the high-level width of the P73/CS# pin in the RL78/G1E (R5F10FMx) satisfies the CS# high-level width (t_{SHA}) prescribed in the SPI section in the electrical specifications in the *RL78/G1E Hardware User's Manual*.

(6) Analog reset control by RL78/G1E (R5F10FMx)

ARESET#, an external reset signal input pin for analog functions in the RL78/G1E (R5F10FMx), is controlled by using the P130 pin output.

The P130 pin in the RL78/G1E (R5F10FMx) is an output-only port pin and outputs a low level during a reset period. That is, a low level is input to the ARESET# pin in the analog block while the microcontroller block of the RL78/G1E (R5F10FMx) is being reset, making the analog block of the RL78/G1E (R5F10FMx) enter the reset state.

The reset state of the analog block of the RL78/G1E (R5F10FMx) ends when the output from the P130 pin is set to high level by using software after the reset period of the microcontroller block of the RL78/G1E (R5F10FMx) ends.

Figure 7.6 shows the pin connections of the analog reset control function in the RL78/G1E (R5F10FMx).

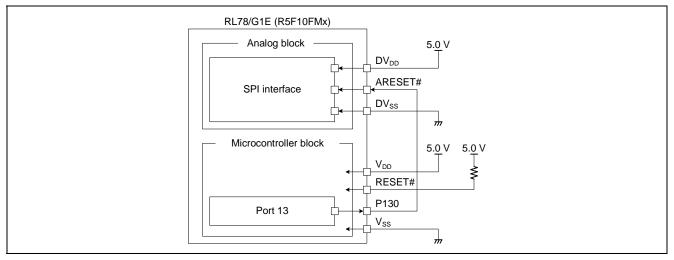


Figure 7.6 Connection of Analog Reset Control Pins in RL78/G1E (R5F10FMx)

Figure 7.7 shows the timing of the analog reset function associated with the microcontroller block of the RL78/G1E.

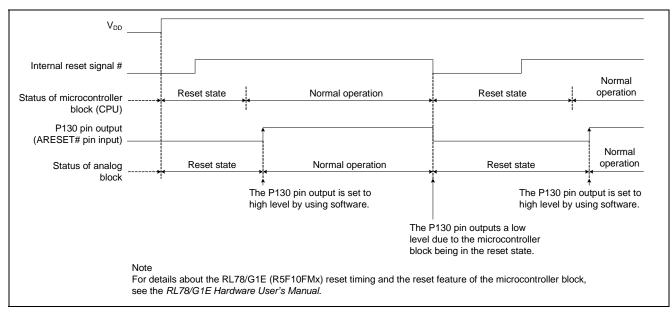


Figure 7.7 Analog Reset Function Associated with the Microcontroller Block of the RL78/G1E

7.2.3 A/D converter

The A/D converter incorporated in the RL78/G1E (R5F10FMx) converts the analog voltage value output from configurable amplifier Ch2 (used as a non-inverting amplifier) in the analog block and stepped down by using a resistor divider to a digital value. The A/D converter incorporated in the RL78/G1E (R5F10FMx) is described below.

(1) A/D converter incorporated in RL78/G1E (R5F10FMx)

In this application note, the signal output from configurable amplifier Ch2 (used as a non-inverting amplifier) in the RL78/G1E (R5F10FMx) and stepped down by using a resistor divider is connected to the ANI2 pin in the A/D converter to enable A/D conversion of signals input to the ANI2 pin.

Specify the settings for the A/D converter as shown below.

- A/D conversion sampling rate: 1 kHz
 - To perform an A/D conversion every 1 ms, use the A/D converter with hardware trigger no-wait mode specified as the trigger mode, select mode specified as the channel selection mode, and one-shot conversion mode specified as the conversion operation mode.
 - Use channel 1 of timer array unit 0 as the hardware trigger source.
- Supply of input clock to A/D converter: Enable
 - Set ADCEN to 1 in peripheral enable register 0 (PER0) to enable supplying the input clock to the A/D converter. (Enable reading from and writing to SFRs used by the A/D converter.)
- Reference voltage source: AV_{DD}/AV_{SS}
 - Set ADREFP1 to 0 and ADREFP0 to 0 in A/D converter mode register 2 (ADM2) to specify AV_{DD} as the reference voltage source for the + side of the A/D converter.
 - Set ADREFM to 0 in A/D converter mode register 2 (ADM2) to specify AV_{SS} as the reference voltage source for the side of the A/D converter.
- A/D conversion time: $54 \mu s$
 - To minimize the effect of signal source impedance, specify $f_{CLK}/32$ ($f_{CLK}=32$ MHz) as the conversion clock (f_{AD}) so as to ensure the longest A/D conversion time. * When 12-bit A/D conversion, no stabilization wait time, and hardware trigger no-wait mode are specified
- Resolution: 12 bits
 - Set ADTYP to 0 in A/D converter mode register 2 (ADM2) to specify 12-bit resolution as the A/D conversion resolution.
- Trigger mode: Hardware trigger no-wait mode
 - Set ADTMD1 to 1 and ADTMD0 to 0 in A/D converter mode register 1 (ADM1) to specify hardware trigger no-wait mode as A/D conversion trigger mode.
- Hardware trigger signal: Timer array unit 0 channel 1 interrupt signal (INTTM01)
 - Set ADTRS1 to 0 and ADTRS0 to 0 in A/D converter mode register 1 (ADM1) to specify the "end of count or capture by channel 1 in timer array unit 0" interrupt signal (INTTM01) as the hardware trigger signal.
- Channel selection mode: Select mode
 - Set ADMD to 0 in A/D converter mode register 0 (ADM0) to specify select mode as the A/D conversion channel selection mode.
- Conversion operation mode: One-shot conversion mode
 - Set ADSCM to 1 in A/D converter mode register 1 (ADM1) to specify one-shot conversion mode as the A/D conversion operation mode.

- Analog input channel: ANI2
 - Set ADISS to 0, ADS4 to 0, ADS3 to 0, ADS2 to 0, ADS1 to 1, and ADS0 to 0 in the analog input channel specification register (ADS) to specify ANI2 as the channel to which to input the analog voltage subject to A/D conversion.

(2) A/D conversion timing chart

Figure 7.8 shows the A/D conversion timing chart when hardware trigger no-wait mode is specified as the trigger mode, select mode is specified as the channel selection mode, and one-shot conversion mode is specified as the conversion operation mode.

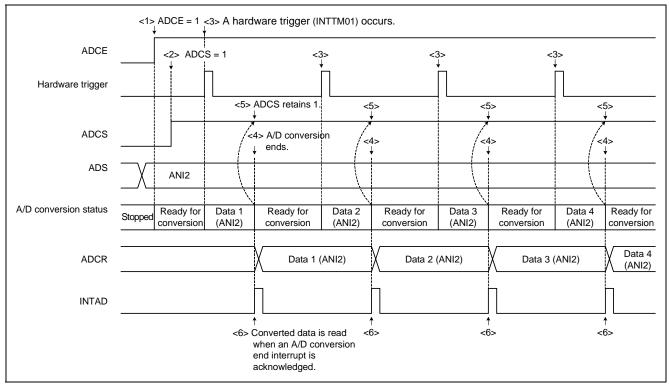


Figure 7.8 A/D Conversion Timing Chart

- <1> ADCE is set to 1 in A/D converter mode register 0 (ADM0) and the A/D converter, which was stopped, enters the A/D conversion ready state. The initial settings are applied to the A/D converter.
- <2> ADCS is set to 1 in the ADM0 register and the A/D converter waits for a hardware trigger to be input. (A/D conversion does not start in this state.) A/D conversion does not start even if ADCS is set to 1 while the A/D converter is waiting for a hardware trigger to be input.
- <3> When the specified hardware trigger (interrupt signal of channel 1 in timer array unit 0 (INTTM01)) is input while ADCS is 1, A/D conversion starts on the analog input channel (ANI2) specified by the analog input channel specification register (ADS).
- <4> When A/D conversion ends, the conversion result is stored in the A/D conversion result register (ADCR), and then the A/D conversion end interrupt request signal (INTAD) is generated.
- <5> When A/D conversion ends, the ADCS bit remains 1 and the A/D converter enters the A/D conversion ready state.
- <6> The A/D conversion result is read from the ADCR register during A/D conversion end interrupt processing.

7.2.4 Timer array unit 0

In this application note, channel 1 of timer array unit 0 is used to generate a hardware trigger signal for the A/D converter, and channel 3 of timer array unit 0 is used to generate the time during which the software is kept waiting (software wait time).

The settings specified for channels 1 and 3 of timer array unit 0 are as follows.

(1) Settings for channel 1 of timer array unit 0

Channel 1 of timer array unit 0 is used to generate a hardware trigger signal for the A/D converter. Using the interval timer in independent channel operation mode, timer array unit 0 generates an A/D converter hardware trigger signal at 1 ms intervals.

Specify the settings for channel 1 of timer array unit 0 as shown below.

- Supply of input clock to timer array unit 0: Enable
 - Set TAU0EN to 1 in peripheral enable register 0 (PER0) to enable supplying the input clock to channel 1 of timer array unit 0. (Enable reading from and writing to SFRs used by timer array unit 0.)
- Mode: Interval timer mode
 - Set MD013 to 0, MD012 to 0, MD011 to 0, and MD010 to 0 in timer mode register 01 (TMR01) to specify interval timer mode as the operating mode of channel 1 of timer array unit 0, and specify that the timer interrupt is not generated when counting starts.
- Interrupt interval: 1 ms
 - Set PRS003 to 0, PRS002 to 0, PRS001 to 0, and PRS000 to 0 in timer clock select register 0 (TPS1) to specify 32 MHz (when f_{CLK} = 32 MHz) as the frequency of the operating clock (CK00).
 - Set CKS011 to 0 and CKS010 to 0 in the TMR01 register to specify the operating clock specified by using the TPS0 register (CK00; 32 MHz) as the operating clock of channel 1 of timer array unit 0 (f_{MCK}).
 - Set CCS01 to 0 in the TMR01 register to specify the operating clock specified by using the CKS011 and CKS010 bits (CK00) as the count clock of channel 1 of timer array unit 0 (f_{TCLK}).
 - Set MASTER01 to 0 in the TMR01 register to specify the independent channel operation mode for channel 1 of timer array unit 0.
 - Set SPLIT01 to 0 in the TMR01 register to specify 16-bit operation for channel 1 of timer array unit 0.
 - Set STS012 to 0, STS011 to 0, and STS010 to 0 in the TMR01 register to specify "only software trigger start is valid (other trigger sources are unselected)" as the start trigger for channel 1 of timer array unit 0.
 - Set timer data register 01 (TDR01) to 7CFFH (31999) to specify 1 ms as the interval of the interrupt generated by channel 1 of timer array unit 0. (31999 + 1) * 1/32000000 = 1 ms

(2) Settings for channel 3 of timer array unit 0

Channel 3 of timer array unit 0 is used to generate the software wait time. Using the interval timer in independent channel operation mode, timer array unit 0 generates a software wait time of 1 ms or 1 µs.

Specify the settings for channel 3 of timer array unit 0 as shown below.

- Supply of input clock to timer array unit 0: Enable
 - Set TAU0EN to 1 in peripheral enable register 0 (PER0) to enable supplying the input clock to channel 1 of timer array unit 0. (Enable reading from and writing to SFRs used by timer array unit 0.)

■ Mode: Interval timer mode

• Set MD033 to 0, MD032 to 0, MD031 to 0, and MD030 to 0 in timer mode register 03 (TMR03) to specify interval timer mode as the operating mode of channel 3 of timer array unit 0, and specify that the timer interrupt is not generated when counting starts.

■ Interrupt interval: 1 ms or 1 μs

- Set PRS003 to 0, PRS002 to 0, PRS001 to 0, and PRS000 to 0 in timer clock select register 0 (TPS1) to specify 32 MHz (when f_{CLK} = 32 MHz) as the frequency of the operating clock (CK00).
- Set CKS031 to 0 and CKS030 to 0 in the TMR03 register to specify the operating clock specified by using the TPS0 register (CK00; 32 MHz) as the operating clock of channel 3 of timer array unit 0 (f_{MCK}).
- Set CCS03 to 0 in the TMR03 register to specify the operating clock specified by using the CKS031 and CKS030 bits (CK00) as the count clock of channel 3 of timer array unit 0 (f_{TCLK}).
- Set MASTER03 to 0 in the TMR03 register to specify the independent channel operation mode for channel 3 of timer array unit 0.
- Set SPLIT03 to 0 in the TMR03 register to specify 16-bit operation for channel 3 of timer array unit 0.
- Set STS032 to 0, STS031 to 0, and STS030 to 0 in the TMR03 register to specify "only software trigger start is valid (other trigger sources are unselected)" as the start trigger for channel 3 of timer array unit 0.
- To set the interrupt interval to 1 ms: Set timer data register 03 (TDR03) to 7CFFH (31999) to specify 1 ms as the interval of the interrupt generated by channel 3 of timer array unit 0. (31999 + 1) * 1/32000000 = 1 ms
- To set the interrupt interval to 1 μ s: Set timer data register 03 (TDR03) to 1FH (31) to specify 1 μ s as the interval of the interrupt generated by channel 3 of timer array unit 0. (31 + 1) * 1/32000000 = 1 μ s

7.2.5 LCD module control

In this application note, the LCD module (ACM0802C) is used to display the physical quantity and results of A/D conversion. The LCD module is controlled by using the output pins of port 4 (P41 and P42) and port 0 (P00 to P03) in the RL78/G1E (R5F10FMx).

Four signal lines are used to interface with the LCD module (4-bit interface). The LCD module can only be written because the R/W# pin of the LCD module is fixed to low level.

Figure 7.9 shows the pin connections of the LCD module.

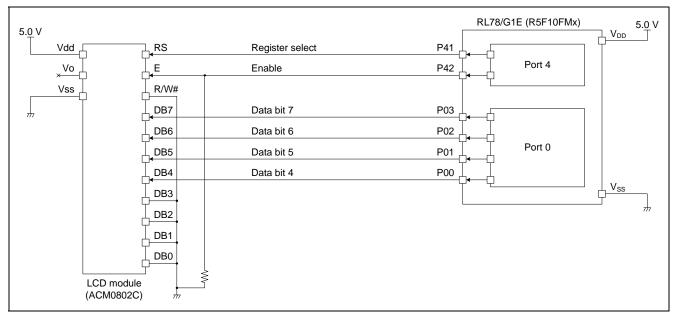


Figure 7.9 Connection of LCD Module

Specify the settings as shown below when using the P41, P42, and P00 to P03 pins as output pins to control the LCD module (ACM0802C).

- Specify the P41 and P42 pins as output pins.
 - Set PMC41 to 0 in port mode control register 4 (PMC4) to specify the P41 pin as a digital I/O pin (alternate function other than analog input).
 - Set P41 to 1 and P42 to 1 in port register 4 (P4) to specify the latched value output from the P41 and P42 pins. (The initial level of the P41 and P42 pin output is set to high.)
 - Set PM41 to 1 and PM42 to 1 in port mode register 4 (PM4) to specify the I/O mode of the P41 and P42 pins as output mode. (The output buffer is turned on.)
- Specify the P00 to P03 pins as output pins.
 - Set PMC02 to 0 and PMC03 to 0 in port mode control register 0 (PMC0) to specify the P02 and P03 pins as digital I/O pins (alternate function other than analog input).
 - Set P01 to 1, P02 to 1, and P03 to 1 in port register 0 (P0) to specify the latched value output from the P00 to P03 pins. (The initial level of the P00 to P03 pin output is set to high.)
 - Set PM03 to 0, PM02 to 0, PM01 to 0, and PM00 to 0 in port mode register 0 (PM0) to specify the I/O mode of the P00 to P03 pins as output mode. (The output buffer is turned on.)

7.2.6 Peak detector control

Because the peak detector holds the peak (maximum value) of the input signal, once a peak voltage is held, the signals of voltages lower than the peak can no longer be measured. To measure the voltage repeatedly, therefore, the held voltage must be reset at specific intervals.

In this application note, the P04 pin of port 0 is used as an N-ch open-drain output (V_{DD} -tolerant) pin to reset the voltage held by the peak detector.

Figure 7.10 shows the pin connection of the peak detector and the P04 output.

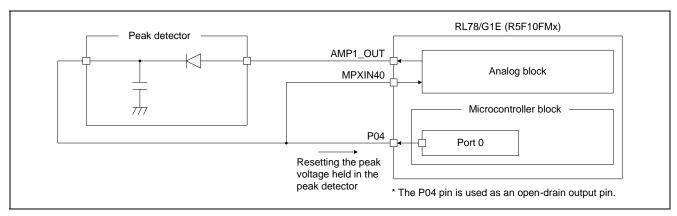


Figure 7.10 Connection Between Peak Detector and P04 Pin

Specify the settings as shown below when using the P04 pin as an N-ch open-drain output pin.

- Set P04 to 1 in port register 0 (P0) to specify the latched value output from the P04 pin.
- Set POM04 to 1 in port output mode register 0 (POM0) to specify the output mode of the P04 pin as N-ch open-drain output (V_{DD}-tolerant).
- Set PM04 to 0 in port mode register 0 (PM0) to specify the I/O mode of the P04 pin as output mode. (The output buffer is turned on.)

7.3 Software

7.3.1 Timing charts

A chart that shows the timing between power application and initial setup and a chart that shows the timing of A/D conversion performed in the RL78/G1E (R5F10FMx), LCD module display update, and control of resetting the voltage held in the peak detector used in this application note are shown below.

(1) Timing between power application and initial setup

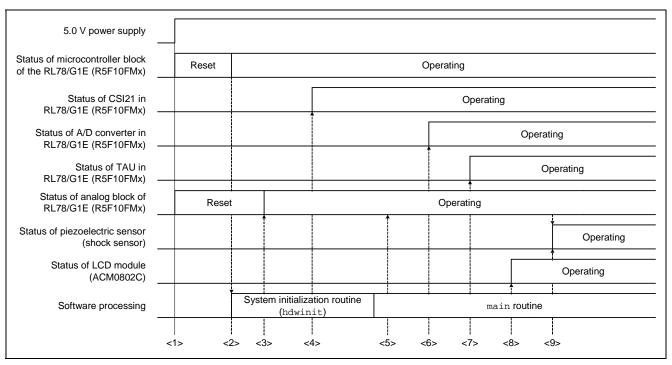


Figure 7.11 Timing Between Power Application and Initial Setup

- <1> When power of 5.0 V is applied, the power-on reset circuit in the microcontroller block of the RL78/G1E starts reset processing. In conjunction with the reset processing, a low level is output from the P130 pin, which places the analog block in the reset state.
- <2> When the reset state in the RL78/G1E (R5F10FMx) is released, software starts the system initialization routine (hdwinit).
- <3> During the system initialization routine (hdwinit), making the P130 pin output high level ends the reset state in the analog block of the RL78/G1E (R5F10FMx).
- <4> During the system initialization routine (hdwinit), channel 1 (CSI21) of serial array unit 1 incorporated in the RL78/G1E (R5F10FMx) is initialized.
- <5> When the system initialization routine (hdwinit) ends, the main routine starts and the variable output voltage regulator in the analog block of the RL78/G1E (R5F10FMx) is turned on and 3.3 V is output from the LDO_OUT pin (AVDD pin input = 3.3 V).
- <6> The A/D converter is initialized during the main routine.
- <7> Timer array unit 0 is initialized during the main routine.
- <8> The LCD module is initialized during the main routine. (4-bit interface)
- <9> The analog block of the RL78/G1E (R5F10FMx) is initialized during the main routine. (The SPI control registers are set up.) Configurable amplifier Ch1 (used as a differential amplifier) in the analog block starts operating and the piezoelectric sensor (shock sensor) starts outputting the differential voltage.

(2) Timing of A/D conversion

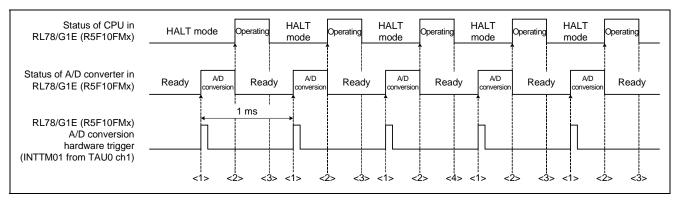


Figure 7.12 Timing of A/D Conversion

- <1> By using channel 1 of timer array unit 0 incorporated in the RL78/G1E (R5F10FMx) as an interval timer, the count end interrupt request signal (INTTM01) is generated at 1 ms intervals. A/D conversion by the A/D converter is started by using INTTM01 as a hardware trigger.
- <2> When the A/D converter incorporated in the RL78/G1E (R5F10FMx) finishes A/D conversion of the data input from the ANI2 pin, an A/D conversion end interrupt request signal (INTAD) is generated, and the CPU exits HALT mode.
- <3> After exiting HALT mode, the CPU incorporated in the RL78/G1E (R5F10FMx) reads the A/D conversion result and stores it in the internal RAM. The CPU enters HALT mode again.

(3) Timing of LCD module display update

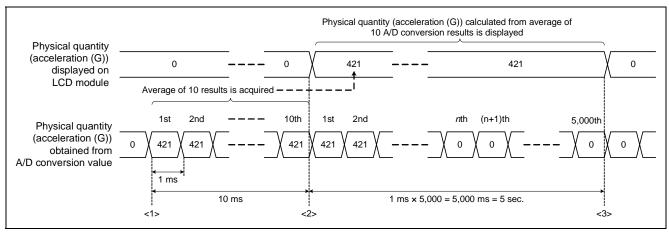


Figure 7.13 Timing of LCD Module Display Update

- <1> The shock sensor output is A/D-converted at 1 ms intervals. If an A/D conversion value larger than the one displayed on the LCD is detected, the CPU acquires the results of the subsequent 10 A/D conversions.
- <2> The CPU calculates the averaged value of the 10 A/D conversion results and calculates the physical quantity (acceleration). The calculated physical quantity (acceleration) and the average of 10 A/D conversion results are displayed.
- <3> If a value larger than the one displayed on the LCD is not output from the shock sensor for 5 seconds (cycles equivalent to 5,000 A/D conversions), the LCD module display is cleared. If a value larger than the one displayed on the LCD is output from the shock sensor, the CPU calculates the averaged value of 10 A/D conversion results in the same manner as <2> and then updates the LCD module display.

(4) Timing of controlling the reset of the peak voltage held by the peak detector

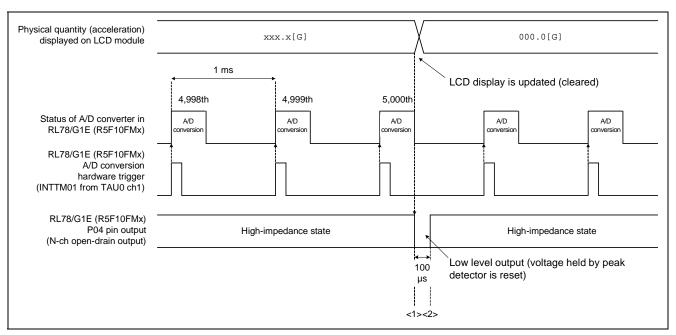


Figure 7.14 Timing of Resetting Voltage Held by Peak Detector

- <1> The P04 pin output (N-ch open-drain output) is set to low when the LCD module display is updated. (The LCD module display is cleared if a value larger than the one displayed on the LCD is not output from the shock sensor during A/D conversion performed 5,000 times.)
- <2> After the P04 pin outputs a low level for 100 μs, the P04 pin output level is set to high impedance.

7.3.2 Register settings specified for the microcontroller block of the RL78/G1E (R5F10FMx)

The register settings specified for the microcontroller block of the RL78/G1E (R5F10FMx) are shown below.

Caution 1 For how to specify the register settings, see the RL78/G1E Hardware User's Manual.

Caution 2 Use the bits for which no description is given with their default values (values following "After reset" on the following pages).

(1) Setting of user option bytes

(a) User option byte 000C0H/010C0H

Address: 000C0H/010C0H Set value: EEH

Address:	7	6	5	4	3	2	1	0
000C0H/	WDTINT	WINDOW	WINDOW	WDTON	WDCS2	WDCS1	WDCS0	WDSTBY
010C0H		1	0					ON
Set value	1	1	1	0	1	1	1	0

WDTINT	Use of interval interrupt of watchdog timer		
0	Interval interrupt is not used.		
1	Interval interrupt is generated when 75% of the overflow time is reached.		

WINDOW	WINDOW	Watchdog timer window open period		
1	0			
0	0	Setting prohibited		
0	1	50%		
1	0	75%		
1	1	100%		

WDTON	Operation of watchdog timer counter		
0	Counter operation disabled (counting stopped after reset)		
1	Counter operation enabled (counting started after reset)		

WDCS2	WDCS1	WDCS0	Watchdog timer overflow time (f _{IL} = 17.25 kHz (Max.))
0	0	0	2 ⁶ /f _{IL} (3.71 ms)
0	0	1	$2^{7}/f_{IL}$ (7.42 ms)
1	1	0	2 ¹⁴ /f _{IL} (949.80 ms)
1	1	1	2 ¹⁶ /f _{IL} (3799.19 ms)

WDSTBY ON	Operation of watchdog timer counter (HALT/STOP mode)
0	Counter operation stopped in HALT/STOP mode
1	Counter operation enabled in HALT/STOP mode

(b) User option byte 000C1H/010C1H

Address: 000C1H/010C1H					Set value: 73H			
Address:	7	6	5	4	3	2	1	0
000C1H/	VPOC2	VPOC1	VPOC0	1	LVIS1	LVIS0	LVIMDS1	LVIMDS0
010C1H								
Set value	0	1	1	1	0	0	1	1

■ When used in reset mode

Dete voltag	ction ge (V)	LVIMDS1	LVIMDS0	VPOC2	VPOC1	VPOC0	LVIS1	LVIS0
V _L	VIH							
Rising edge	Falling edge							
3.13	3.06	1	1	0	0	1	0	0
3.75	3.67			0	1	0	0	0
4.06	3.98			0	1	1	0	0
Other that	Other than above Setting prohibited							

(c) User option byte 000C2H/010C2H

Address: 000C2H/010C2H Set value: E8H 3 1 0 Address: 6 5 7 4 000C2H/ FRQSEL CMODE1 CMODE0 0 **FRQSEL FRQSEL FRQSEL** 1 3 2 0 010C2H 1 1 1 1 0 1 0 0 0 Set value

CMODE1	CMODE0	Setting of flash operation mode				
			Operating	Operating		
			frequency range	voltage range		
0	0	LV (low voltage main) mode	1 to 4 MHz	1.6 to 5.5 V		
1	0	LS (low speed main) mode	1 to 8 MHz	1.8 to 5.5 V		
1	1	HS (high speed main) mode	1 to 16 MHz	2.4 to 5.5 V		
			1 to 32 MHz	2.7 to 5.5 V		
Other than	above	Setting prohibited				

FRQSEL	FRQSEL	FRQSEL	FRQSEL	Frequency of high-speed on-chip oscillator
3	2	1	0	
1	0	0	0	32 MHz
0	0	0	0	24 MHz
1	1	0	1	1 MHz
Other than above				Setting prohibited

(2) Settings of registers that control the clock generator

(a) Clock operation mode control register (CMC)

Address: FFFA0H		Afte	r reset: 00H	R/W	1	Set value: 10	DΗ	
Symbol	7	6	5	4	3	2	1	0
CMC	EXCLK	OSCSEL	0	0	0	0	0	AMPH
Set value	0	0	0	1	0	0	0	0

EXCLK	OSCSEL	High-speed system clock pin operation mode	X1/P121 pin X2/EXCLK/P122			
0	0	Input port mode	Input port			
0	1	XT1 oscillation mode	Crystal/ceramic resonator connection			
1	0	Input port mode	Input port			
1	1	External clock input mode	Input port	External clock input		

(b) Clock operation status control register (CSC)

Address: FFFA1H		After reset: C0H		R/W	R/W		Set value: C0H	
Symbol	7	6	5	4	3	2	1	0
CSC	MSTOP	1	0	0	0	0	0	HIOSTOP
Set value	1	1	0	0	0	0	0	0

MSTOP	High-speed system clock operation					
	XT1 oscillation mode	External clock input mode	Input port mode			
0	X1 oscillator operating	External clock from EXCLK pin is valid	Input port			
1	X1 oscillator stopped	External clock from EXCLK pin is invalid				

HI	OSTOP	High-speed on-chip oscillator clock operation
	0	High-speed on-chip oscillator operating
	1	High-speed on-chip oscillator stopped

(c) System clock control register (CKC)

Address: FFFA4H		Afte	r reset: 00H	R/W		Set value: 00	DΗ	
Symbol	7	6	5	4	3	2	1	0
CKC	CLS	0	MCS	MCM0	0	0	0	0
Set value	0	0	0	0	0	0	0	0

MCM0	Main system clock (f _{MAIN}) operation
0	The high-speed on-chip oscillator clock (f_{MAIN}) is selected as the main system clock (f_{IH})
1	The high-speed system clock (f _{MX}) is selected as the main system clock (f _{MAIN})

(d) Peripheral enable register 0 (PER0)

Address: F0	0F0H	Afte	r reset: 00H	R/W	,	Set value: 29		
Symbol	7	6 5		4	3	3 2		0
PER0	RTCEN	0 ADCEN		0	SAU1EN	SAU1EN SAU0EN		TAU0EN
Set value	0	0	1	0	1	0	0	1

RTCEN	Control of interval timer input clock supply
0	Stop the input clock supply.
	SFRs used by the interval timer cannot be written.
	The interval timer is in the reset status.
1	Enable the input clock supply.
	SFRs used by the interval timer can be written.

ADCEN	Control of A/D converter input clock supply			
0	Stop the input clock supply.			
	SFRs used by the A/D converter cannot be written.			
	A/D converter is in the reset status.			
1	Enable the input clock supply.			
	SFRs used by the A/D converter can be written.			

SAU1EN	Control of serial array unit 1 input clock supply
0	Stop the input clock supply.
	SFRs used by serial array unit 1 cannot be written.
	Serial array unit 1 is in the reset status.
1	Enable the input clock supply.
	SFRs used by serial array unit 1 can be written.

SAU0EN	Control of serial array unit 0 input clock supply
0	Stop the input clock supply.
	SFRs used by serial array unit 0 cannot be written.
	Serial array unit 0 is in the reset status.
1	Enable the input clock supply.
	SFRs used by serial array unit 0 can be written.

TAU0EN	Control of timer array unit 0 input clock supply
0	Stop the input clock supply.
	SFRs used by timer array unit 0 cannot be written.
	Timer array unit 0 is in the reset status.
1	Enable the input clock supply.
	SFRs used by timer array unit 0 can be written.

- (3) Settings of registers that control serial array unit 1
- (a) Serial mode register 11 (SMR11)

Address:	F0152	H, F0	153H	Af	ter res	et: 002	20H	RΛ	Ν		Set v	alue: 0	02*H			
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SMR11	CKS11	CCS11	0	0	0	0	0	STS11	0	SIS110	1	0	0	MD112	MD111	MD110
Set value	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	*

CKS11	Selection of operation clock of channel 1 (f _{MCK})
0	Operation clock set by the SPS1 register (CK10)
1	Operation clock set by the SPS1 register (CK11)

CCS11	Selection of transfer clock of channel 1 (f _{TCLK})
0	Divided clock of operation clock (f _{MCK}) specified by the CKS11 bit
1	Clock input from the SCK21 pin (slave transfer in CSI mode) (f _{SCK})

STS11	Selection of start trigger source
0	Only software trigger is valid (selected for CSI, UART transmission, and simplified I ² C)
1	Valid edge of the RXD2 pin (selected for UART reception)

MD112	MD111	Setting of operation mode of channel 1
0	0	CSI mode
0	1	UART mode
1	0	Simplified I ² C mode
1	1	Setting prohibited

MD110	Selection of interrupt source of channel 1
0	Transfer end interrupt
1	Buffer empty interrupt (Occurs when data is transferred from the SDR11 register to the shift register.)

Remark: * = Switch the transfer end interrupt (= 0) and buffer empty interrupt (= 1) by using software.

(b) Serial communication operation setting register 11 (SCR11)

Address:	F015A	λH, F0	15BH			After reset: 0087H				R/W			Set value: C007H			
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SCR11	TXE11	RXE11	DAP11	CKP11	0	E0C11	PTC111	PTC110	DIR11	0	0	SLC110	0	1	1	DLS110
Set value	1	1	0	0	0	0	0	0	0	0	0	0	0	1	1	1

TXE11	RXE11	Setting of operation mode of channel 1
0	0	Disable communication.
0	1	Reception only
1	0	Transmission only
1	1	Transmission and reception

DAP11	CKP11		Selection of data and clock phase in CSI mode
0	0	Type 1	
0	1	Type 2	
1	0	Type 3	
1	1	Type 4	

DIR11	Selection of data transfer sequence in CSI and UART modes
0	Input/output data MSB first.
1	Input/output data LSB first.

DLS110	Setting of data length in CSI and UART modes
0	7-bit data length (stored in bits 0 to 6 of the SDR11 register)
1	8-bit data length (stored in bits 0 to 7 of the SDR11 register)

(c) Serial data register 11 (SDR11)

Address:	FFF4	λH, FF	F4BH			After r	eset: 0	000H	F	R/W Set value: 1E**H					ł	
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SDR11																
Set value	0	0	0	1	1	1	1	0	*	*	*	*	*	*	*	*

		SD	R11[1	5:9]			Selection of transfer clock (divided operating clock (f _{MCK}))
0	0	0	0	0	0	0	f _{MCK} /2
0	0	0	0	0	0	1	f _{MCK} /4
0	0	0	1	1	1	1	f _{MCK} /32
1	1	1	1	1	1	0	f _{MCK} /254
1	1	1	1	1	1	1	f _{MCK} /256

Remark: * = Functions as a transmission/reception buffer register.

(d) Serial channel stop register 1 (ST1)

Address:	165H	After reset: 0000H				R۸	Ν		Set value:			H*00				
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ST1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	ST11	ST10
Set value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	*	0

Ī	ST11	Operation stop trigger of channel 1
Ī	0	No trigger operation
Ī	1	Clear the SE11 bit to 0 and stop the communication operation.

Remark: * = Write 1 to this bit only when finishing serial communication.

(e) Serial clock select register 1 (SPS1)

Address:	After reset: 0000H				R/W			Set value: 0000H								
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SPS1	0	0	0	0	0	0	0	0	PRS113	PRS112	PRS111	PRS110	PRS103	PRS102	PRS101	PRS100
Set value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

33	2	Ξ	0	Selection of operation clock (CK10)									
PRS103	PRS102	PRS101	PRS100		f _{CLK} = 2 MHz	f _{CLK} = 5 MHz	f _{CLK} = 10 MHz	f _{CLK} = 20 MHz	f _{CLK} = 32 MHz				
0	0	0	0	f _{CLK}	2 MHz	5 MHz	10 MHz	20 MHz	32 MHz				
0	0	0	1	f _{CLK} /2	1 MHz	2.5 MHz	5 MHz	10 MHz	16 MHz				
							•						
1	1	1	0	f _{CLK} /2 ¹⁴	122 Hz	305 Hz	610 Hz	1.22	1.95				
								kHz	kHz				
1	1	1	1	f _{CLK} /2 ¹⁵	61 Hz	153 Hz	305 Hz	610 Hz	976 Hz				

(f) Serial output register 1 (SO1)

Address:	169H	After reset: 0F0FH				R/W			Set value: 0301H							
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SO1	0	0	0	0	0	0	CKO11	CKO10	0	0	0	0	0	0	SO11	SO10
Set value	0	0	0	0	0	0	1	1	0	0	0	0	0	0	0	1

CKO11	Serial clock output of channel 1
0	Serial clock output value is "0".
1	Serial clock output value is "1".

SO11	Serial clock output of channel 1
0	Serial data output value is "0".
1	Serial data output value is "1".

(g) Serial output enable register 1 (SOE1)

Address:	F016A	H, F0	16BH	Af	ter res	et: 000	HOC	R٨	Ν		Set v	alue: 0	002H			
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SOE1															_	10
	0	0	0	0	0	0	0	0	0	0	0	0	0	0	3OE1	SOE1
															S	(U
Set value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0

SOE11	Serial output enable/stop of channel 1
0	Stop output by using serial communication.
1	Enable output by using serial communication.

(h) Serial channel start register 1 (SS1)

Address:	F0162	H, F0	163H	Af	ter res	et: 000	HOC	R۸	Ν		Set v	alue: 0	002H			
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SS1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	SS11	SS10
Set value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0

SS11	Operation start trigger of channel 1
0	No trigger operation
1	Clear the SE11 bit to 1 and enter the communication wait status.

(4) Settings of registers that control the ports

(a) Port mode registers

Address: FFF	Address: FFF20H		FFH	R/W	Set valu	e: 80H		
Symbol	7	6	5	4	3	2	1	0
PM0	1	PM06	PM05	PM04	PM03	PM02	PM01	PM00
Set value	1	0	0	0	0	0	0	0
	-0411	A.C		D 444	0	DELL		
Address: FFF		After reset: I		R/W	Set valu			
Symbol	7	6	5	4	3	2	1	0
PM1	1	PM16	PM15	PM14	PM13	PM12	PM11	PM10
Set value	1	0	1	1	1	1	1	1
Address: FFF	F22H	After reset: I	FFH	R/W	Set valu	e: 1FH		
Symbol	7	6	5	4	3	2	1	0
PM2	PM27	PM26	PM25	PM24	PM23	PM22	PM21	PM20
Set value	0	0	0	1	1	1	1	1
Address: FFF		After reset: I		R/W	Set valu			
Symbol	7	6	5	4	3	2	1	0
PM4	1	1	1	1	PM43	PM42	PM41	PM40
Set value	1	1	1	1	0	0	0	1
Address: FFF	=26H	After reset: I	FFH	R/W	Set valu	e: F0H		
Symbol	7	6	5	4	3	2	1	0
PM6	1	1	1	1	PM63	PM62	PM61	PM60
Set value	1	1	1	1	0	0	0	0
				D 444	0	2211		
Address: FFF		After reset: I		R/W	Set valu		4	0
Symbol	7	6 DM70	5 PM75	4 PM74	3	2 PM72	1	0
PM7	PM77 0	PM76 0		0 0	PM73 0	0 0	PM71	PM70
Set value	U	0	0	U	U	U	1	0
Address: FFF	F2EH	After reset: I	FFH	R/W	Set valu	e: FDH		
Symbol	7	6	5	4	3	2	1	0
PM14	1	1	1	1	1	1	PM141	PM140
Set value	1	1	1	1	1	1	0	1
_		•	•	•				
Address: FFF	F2FH	After reset: I		R/W	Set valu			
Symbol	7	6	5	4	3	2	1	0
PM15	1	1	1	PM154	PM153	PM152	PM151	PM150
Set value	1	1	1	0	0	0	0	0

PMmn	PMmn pin I/O mode selection (m = 0 to 2, 4, 6, 7, 14, 15; n = 0 to 7)
0	Output mode (output buffer on)
1	Input mode (output buffer off)

(b) Port reg	isters							
Address: FFF	F00H	After reset: (00H	R/W	Set valu	e: **H		
Symbol	7	6	5	4	3	2	1	0
P0	0	0	0	P04	P03	P02	P01	P00
Set value	0	0	0	*	*	*	*	*
Address: FFF	- - - - - - - - - - - - - - - - - - -	After reset: (00H	R/W	Set valu	e: 0*H		
Symbol	7	6	5	4	3	2	1	0
P4	0	0	0	0	0	P42	P41	P40
Set value	0	0	0	0	0	*	*	0
Address: FFF	- 07H	After reset: (00H	R/W	Set valu	e: 0*H		
Symbol	7	6	5	4	3	2	1	0
P7	0	0	0	0	P73	P72	P71	P70
Set value	0	0	0	0	*	1	0	1
Address: FFF	ODH	After reset: I	Undefined	R/W	Set valu	e: 01H		
Symbol	7	6	5	4	3	2	1	0
P13	P137	0	0	0	0	0	0	P130
Set value	0	0	0	0	0	0	0	1

Pmn	(m = 0, 4, 7, 13,	n = 0 to 4, or 7)
	Output data control (in output mode)	Input data read (in input mode)
0	Output 0	Input a low level
1	Output 1	Input a high level

Remark: * = Write 0 or 1 to switch the output level according to the status.

(c) Port mode control registers

Address: FF	F60H	After reset: I	FFH	R/W	Set value	e: F3H		
Symbol	7	6	5	4	3	2	1	0
PMC0	1	1	1	1	PMC03	PMC02	1	1
Set value	1	1	1	1	0	0	1	1
			,	,				_
Address: FF	F64H	After reset: I	FFH	R/W	Set value	e: FDH		
Symbol	7	6	5	4	3	2	1	0
PMC4	1	1	1	1	1	1	PMC41	1
Set value	1	1	1	1	1	1	0	1
Address: FFF67H		After reset: I	FFH	R/W	Set value	e: FEH		
Symbol	7	6	5	4	3	2	1	0
PMC7	1	1	1	1	1	1	1	PMC70
Set value	1	1	1	1	1	1	1	0

PMCmn	Pmn pin digital I/O and analog input selection (m = 0, 4, 7; n = 0 to 3)
0	Digital I/O (alternate function other than analog input)
1	Analog input

(d) Port output mode register 0 (POM0)

Address: F0050H		After reset: 00H		R/W	Set valu	e: 10H		
Symbol	7	6	5	4	3	2	1	0
POM0	0	0	0	POM04	POM03	POM02	0	0
Set value	0	0	0	1	0	0	0	0

POM04	P04 pin output mode selection				
0	Normal output mode				
1	N-ch open-drain output (V _{DD} tolerance) mode				

- (5) Settings of registers that control A/D converter
- (a) A/D converter mode register 0 (ADM0)

Address: FF	F30H	After reset: 00H		R/W	Set valu	Set value: 81H		
Symbol	7	6	5	4	3	2	1	0
ADM0	ADCS	ADMD	FR2	FR1	FR0	LV1	LV0	ADCE
Set value	1	0	0	0	0	0	0	1

ADCS	A/D conversion operation							
0	Stop conversion operation							
	When read]							
	Conversion stopped/standby status							
1	Enable conversion operation							
	[When read]							
	While in the software trigger mode: Conversion operation status							
	While in the hardware trigger wait mode: Stabilization wait status + conversion							
	operation status							

ADMD	Specification of the A/D conversion channel selection mode					
0	Select mode					
1	Scan mode					

ADCE	A/D voltage comparator operation					
0	Stop A/D voltage comparator operation					
1	Enable A/D voltage comparator operation					

■ When performing 12-bit A/D conversion, no stabilization wait time, and hardware trigger no-wait mode are specified

FR2	FR1	FR0	LV1	LV0	Mode	Number of conversion clock cycles (f _{CLK})	Conversion time selection $AV_{DD} = 2.7 \text{ to } 3.6 \text{ V}$ $f_{CLK} = 32 \text{ MHz}$	Conversion clock (f _{AD})
0	0	0	0	0	Normal	1728	54 μs	f _{CLK} /32
0	0	1			1	864	27 µs	f _{CLK} /16
							•••	
1	1	0				108	3.375 µs	f _{CLK} /2
1	1	1				54	Setting prohibited	f _{CLK} /1
0	0	0	0	1	Normal	2112	66 µs	f _{CLK} /32
0	0	1			2	1056	33 µs	f _{CLK} /16
1	1	0				132	4.125 μs	f _{CLK} /2
1	1	1				66	Setting prohibited	f _{CLK} /1
0	0	0	1	0	Low-	2432	76 µs	f _{CLK} /32
0	0	1			voltage	1216	38 µs	f _{CLK} /16
					1			
1	1	0				152	4.75 μs	f _{CLK} /2
1	1	1				76	Setting prohibited	f _{CLK} /1
0	0	0	1	1	Low-	7360	230 µs	f _{CLK} /32
0	0	1			voltage	3680	115 µs	f _{CLK} /16
					2	•••		
1	1	0				460	14.375 μs	f _{CLK} /2
1	1	1				230	Setting prohibited	f _{CLK} /1

(b) A/D converter mode register 1 (ADM1)

Address: FFF32H		After reset: 00H		R/W	Set value: A0H			
Symbol 7		6	5	4	3	2	1	0
ADM1	ADTMD1	ADTMD0	ADSCM	0	0	0	ADTRS1	ADTRS0
Set value	1	0	1	0	0	0	0	0

ADTMD1	ADTMD0	Selection of the A/D conversion trigger mode				
0	×	oftware trigger mode				
1	0	Hardware trigger no-wait mode				
1	1	Hardware trigger wait mode				

ſ	ADSCM	A/D conversion operation				
ſ	0	Sequential conversion mode				
ſ	1	One-shot conversion mode				

ADTRS1	ADTRS0	Selection of the hardware trigger signal
0	0	"End of timer channel 1 count or capture" interrupt signal (INTTM01)
0	1	Setting prohibited
1	0	Setting prohibited
1	1	Interval timer interrupt signal (INTIT)

Remark x: don't care

(c) A/D converter mode register 2 (ADM2)

Address: F0010H		After reset: 00H		R/W	Set valu	e: 00H		
Symbol 7		6	5	4	3	2	1	0
ADM2	ADREFP1	ADREFP0	ADREFM	0	ADRCK	AWC	0	ADTYP
Set value	0	0	0	0	0	0	0	0

AVREFP1	AVREFP0	Selection of the + side reference voltage source of the A/D converter
0	0	Supplied from AV _{DD}
0	1	Supplied from P20/AV _{REFP} /ANI0
1	0	Supplied from the internal reference voltage source (1.45 V)
1	1	Setting prohibited

ADREFM	Selection of the – side reference voltage source of the A/D converter
0	Supplied from AV _{SS}
1	Supplied from P21/AV _{REFM} /ANI1

ADRCK	Checking the upper limit and lower limit conversion result values
0	The interrupt signal (INTAD) is output when ADLL register ≤ ADCR register ≤ ADUL register.
1	The interrupt signal (INTAD) is output when ADCR register < ADLL register or ADUL register < ADCR register.

Α	WC	Specification of SNOOZE mode								
	0	Do not use the SNOOZE mode function.								
	1	Use the SNOOZE mode function.								

ADTYP	Selection of the A/D conversion resolution
0	12-bit resolution
1	8-bit resolution

(d) Conversion result comparison upper limit setting register (ADUL)

Address: F0	011H	After reset: F	-FH	R/W	Set valu	e: FFH		
Symbol	7	6	5	4	3	2	1	0
ADUL	ADUL7	ADUL6	ADUL5	ADUL4	ADUL3	ADUL2	ADUL1	ADUL0
Set value	1	1	1	1	1	1	1	1

(e) Conversion result comparison lower limit setting register (ADLL)

Address: F0	012H	After reset: 0	00H	R/W	Set valu	e: 00H		
Symbol 7		6 5		4	3	2	1	0
ADLL	ADLL7	ADLL6	ADLL5	ADLL4	ADLL3	ADLL2	ADLL1	ADLL0
Set value	0	0	0	0	0	0	0	0

(f) Analog input channel specification register (ADS)

Address: FF	F31H	After reset: 0	00H	R/W	Set valu	e: 02H			
Symbol	7	6 5		4	3	3 2		0	
ADS	ADISS	0	0	ADS4	ADS3	ADS2	ADS1	ADS0	
Set value	0	0	0	0	0	0	1	0	

■ Select mode (ADMD = 0)

ADISS	ADS4	ADS3	ADS2	ADS1	ADS0	Selected channel	Input source
0	0	0	0	0	0	ANI0	P20/ANI0/AV _{REFP} pin
0	0	0	0	0	1	ANI1	P21/ANI1/AV _{REFP} pin
0	0	0	0	1	0	ANI2	P22/ANI2 pin
0	0	0	0	1	1	ANI3	P23/ANI3 pin
0	0	0	1	0	0	ANI4	P24/ANI4 pin
0	1	0	0	0	0	ANI16	P03/ANI16 pin
0	1	0	0	0	1	ANI17	P02/ANI17 pin
0	1	0	0	1	0	ANI18	P10/ANI18 pin
0	1	0	1	0	0	ANI20	P11/ANI20 pin
0	1	0	1	0	1	ANI21	P12/ANI21 pin
0	1	0	1	1	0	ANI22	P13/ANI22 pin
0	1	0	1	1	1	ANI23	P14/ANI23 pin
0	1	1	0	0	0	ANI24	P15/ANI24 pin
0	1	1	0	0	1	ANI25	P51/ANI25 pin
0	1	1	0	1	0	ANI26	P50/ANI26 pin
0	1	1	1	0	0	ANI28	P70/ANI28 pin
0	1	1	1	1	0	ANI30	P41/ANI30 pin
1	0	0	0	0	0	_	Temperature sensor
1	0	0	0	0	1	_	Internal reference voltage output (1.45 V)
Other th	an above			Setting prohibited			

(g) A/D port configuration register (ADPC)

Address: F0	076H	After reset: 0	00H	R/W	Set valu	e: 00H		
Symbol 7		6	5	4	3	2	1	0
ADPC	0	0	0	0	0	ADPC2	ADPC1	ADPC0
Set value	0	0	0	0	0	0	0	0

ADPC2	ADPC1	ADPC0	Switching between analog input (A) and digital I/O (D)									
			ANI4/P24	ANI3/P23	ANI2/P22	ANI1/P21	ANI0/P20					
0	0	0	Α	Α	Α	Α	Α					
0	0	1	D	D	D	D	D					
0	1	0	D	D	D	D	Α					
0	1	1	D	D	D	А	Α					
1	0	0	D	D	Α	А	Α					
1	0	1	D	Α	Α	Α	A					
Other than	above		Setting prohibited									

(6) Settings of registers that control timer array unit 0

(a) Timer channel stop register 0 (TT0)

Address: F01B4H, F01B5H			After reset: 0000H			HOC	R/W		Set value: 000*H							
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TT0	0	0	0	0	ттноз	0	ттн01	0	TT07	TT06	TT05	TT04	TT03	TT02	TT01	TT00
Set value	0	0	0	0	0	0	0	0	0	0	0	0	*	0	*	0

TT03	Operation stop trigger of channel 3
0	No trigger operation
1	Operation is stopped (stop trigger is generated).

TT01	Operation stop trigger of channel 1
0	No trigger operation
1	Operation is stopped (stop trigger is generated).

Remark: * = Write 1 to this bit during timer operation to stop the timer operation.

(b) Timer clock selection register 0 (TPS0)

Address:	F01B6	6H, F0	1B7H	Af	After reset: 0000H				R/W Set value: 0000H							
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TPS0	0	0	PRS031	PRS030	0	0	PRS021	PRS020	PRS013	PRS012	PRS011	PRS010	PRS003	PRS002	PRS001	PRS000
Set value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

83	2		00		Selecti	on of opera	tion clock	(CK00)	
PRS003	PRS002	PRS001	PRS000		f _{CLK} = 2 MHz	f _{CLK} = 5 MHz	f _{CLK} = 10 MHz	f _{CLK} = 20 MHz	f _{CLK} = 32 MHz
0	0	0	0	f _{CLK}	2 MHz	5 MHz	10 MHz	20 MHz	32 MHz
0	0	0	1	f _{CLK} /2	1 MHz	2.5 MHz	5 MHz	10 MHz	16 MHz
1	1	1	0	f _{CLK} /2 ¹⁴	122 Hz	305 Hz	610 Hz	1.22 kHz	1.95 kHz
1	1	1	1	f _{CLK} /2 ¹⁵	61 Hz	153 Hz	305 Hz	610 Hz	976 Hz

Set value

0

0

(c) Time	er mod	le regis	sters													
Address:	F0192	H, F0	193H	Af	ter res	et: 00	00H	RΛ	N		Set v	alue: 0	H0000			
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TMR01	CKS011	CKS010	0	CCS01	SPLIT01	STS012	STS011	STS010	CIS011	CIS010	0	0	MD013	MD012	MD011	MD010
0-4	•			-		_	-									
Set value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Address: Symbol					ter res	l .		0 RΛ 8		0		0 alue: 0		2	0	0

0

0

0

CKS0n1	CKS0n0	Selection of operation clock (f_{MCK}) of channel n (n = 1, 3)
0	0	Operation clock set by timer clock select register 0 (TPS0) (CK00)
0	1	Operation clock set by timer clock select register 0 (TPS0) (CK01)
1	0	Operation clock set by timer clock select register 0 (TPS0) (CK02)
1	1	Operation clock set by timer clock select register 0 (TPS0) (CK03)

0

0

0

0

CCS0n	Selection of count clock (f _{TCLK}) of channel n (n = 1, 3)
0	Operation clock specified by the CKS0n0 and CKS0n1 bits (f _{MCK})
1	Valid edge of input signal input from the TI0n pin

SPLIT0n	Selection of 8 or 16-bit timer operation for channel n (n = 1, 3)
0	Operate as a 16-bit timer. (Operate in independent channel operation mode or as
	a slave channel in simultaneous channel operation mode.)
1	Operate as an 8-bit timer.

STS0n2	STS0n1	STS0n0	Setting of start trigger or capture trigger of channel n (n = 1, 3)
0	0	0	Only software trigger start is valid (other trigger sources are unselected).
0	0	1	The valid edge of the T0mn pin input is used as both the start trigger and capture trigger.
0	1	0	Both the edges of the TI0n pin input are used as a start trigger and a capture trigger.
1	0	0	The interrupt signal of the master channel is used (when the channel is used as a slave channel in simultaneous channel operation mode).
Other tha	n above		Setting prohibited

MD0n3	MD0n2	MD0n1	MD0n0	Operation mode of channel n (n = 1, 3)	Corresponding function	Count operation of TCR
0	0	0	1/0	Interval timer mode	Interval timer/Square wave output/Divider function/PWM output (master)	Counting down
0	1	0	1/0	Capture mode	Input pulse interval measurement	Counting up
0	1	1	0	Event counter mode	External event counter	Counting down
1	0	0	1/0	One-count mode	Delay counter/One-shot pulse output/PWM output (slave)	Counting down
1	1	0	0	Capture & one-count mode	Measurement of high-/low-level width of input signal	Counting up
Other than above)	Setting prohibited		

Operation mode	MD0n0	Setting of starting counting and interrupt
(Value set by the MD0n3 to MD0n1		
bits) (n = 1, 3)		
• Interval timer mode (0, 0, 0)	0	A timer interrupt is not generated when
• Capture mode (0, 1, 0)		counting is started (the timer output does
		not change).
	1	A timer interrupt is generated when counting is
		started (the timer output also changes).

(d) Timer data registers

Address: FFF1AH, FFF1BH			After reset: 0000H				R/W			Set value: 7CFFH						
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TDR01																
Set value	0	1	1	1	1	1	0	0	1	1	1	1	1	1	1	1
Address:	FFF66	SH, FF	F67H	After reset: 0000H			HOC	R/W			Set value: ****H					
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TDR03																
Set value	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*

Remark: * = Change the setting by using software to use channel 3 of timer array unit 0 as an interval timer, and to set the interrupt interval to 1 ms or 1 μ s.

(e) Timer channel start register 0 (TS0)

Address: F01B2H, F01B3H			After reset: 0000H			R/W			Set value: 000AH							
Symbol	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TS0	0	0	0	0	E0HST	0	TSH01	0	1807	9081	20ST	TS04	TS03	1802	TS01	TS00
Set value	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	0

TS0n	Operation enable (start) trigger of channel n (n = 1, 3)
0	No trigger operation
1	The TE0n bit is set to 1 and the count operation is enabled.

7.3.3 Functions

Table 7.2 Functions

Function Name	Overview
main	Main routine function
R5F10FMx_LDO_Enable	Analog block LDO initialization function
R5F10FMx_REG_SET_SHOCK_SENSOR	Analog block initialization function
R_Systeminit	MCU initialization function
hdwinit	System initialization function
R_CGC_Create	Clock generator initialization function
R_PORT_Create	Port initialization function
Refresh_PeakHoldVoltage	Peak detector control function
R_SAU1_Create	SAU1 initialization function
R_CSI21_Create	CSI21 initialization function
R_CSI21_Start	CSI21 operation start function
R_CSI21_Stop	CSI21 operation stop function
R_CSI21_Send_Receive	CSI21 transmission/reception function
r_csi21_interrupt	INTCSI21 interrupt service function
r_csi21_callback_receiveend	CSI21 reception completion function
R5F10FMx_Send_Receive	Function for performing SPI communication with the analog
	block
R_ADC_Create	ADC initialization function
R_ADC_Start	ADC operation start function
R_ADC_Stop	ADC operation stop function
R_ADC_Set_OperationOn	ADC comparator operation enable function
R_ADC_Set_OperationOff	ADC comparator operation stop function
R_ADC_Get_Result	A/D conversion result read function
r_adc_interrupt	INTAD interrupt service function
ADC_Trigger_Start	ADC trigger operation start function
ADC_Trigger_Stop	ADC trigger operation stop function
ADC_Get_AD_Buffer_Value	A/D conversion result acquisition function
R_TAUO_Create	TAU0 initialization function
R_TAU0_Channel1_Start	TAU0 ch1 counter operation start function
R_TAU0_Channel1_Stop	TAU0 ch1 counter operation stop function
R_TAU0_Channel3_Start	TAU0 ch3 counter operation start function
R_TAU0_Channel3_Stop	TAU0 ch3 counter operation stop function
TAU0_Channel3_ChangeTimerCondition	TAU0 ch3 counter value change function
TAU0_WAIT_1ms	1-ms unit wait function
TAU0_WAIT_1us	1-µs unit wait function
write_lcd	LCD module write function
LCD_Init	LCD module initialization function
lcd_puts	Character string display function
LCD_Sensor_Out	LCD module measurement result display function
LCD_Err_Display	LCD module error display function

7.3.4 Function specifications

Declaration	void main(void)
Overview	Main routine function
Parameters	None
Return value	None
Return value Description	 Calls the R5F10FMx_LDO_Enable function to initialize the variable output voltage regulator in the analog block. (LDO_OUT pin output = 3.3 V) Calls the R_ADC_Create function to initialize the A/D converter. Calls the R_TAU0_Create function to initialize timer array unit 0. Calls the LCD_Init function to initialize the LCD module. Calls the R5F10FMx_REG_SET_SHOCK_SENSOR function to initialize the analog block. Calls the Refresh_PeakHoldVoltage function to initialize the peak detector. Calls the LCD_Sensor_Out function to initialize the LCD module display. Calls the ADC_Trigger_Start function to start the A/D converter trigger operation. The CPU enters HALT mode. The CPU exits HALT mode when the A/D conversion end interrupt request signal (INTAD) is generated. Calls the ADC_Get_AD_Buffer_Value function to acquire the A/D conversion results. Calculates the averaged value of 10 A/D conversion results when an output from the shock sensor is detected. Calculates the physical quantity (acceleration) from the averaged value of the A/D conversion results.
	Calls the LCD_Sensor_Out function to display the physical quantity (acceleration) calculated from the A/D conversion result and the averaged value of the A/D conversion results on the LCD module.
	Calls the Refresh_PeakHoldVoltage function to reset the peak voltage and clears the LCD module display if a value larger than the physical quantity (acceleration) displayed on the LCD module is not output for 5 seconds.

Declaration	static uint8_t R5F10FMx_LDO_Enable(void)
Overview	Analog block LDO initialization function
Parameters	None
Return value	0: Successful
	1: Communication with the analog block failed
Description	 Calls the R5F10FMx_Send_Receive function to initialize the variable output voltage regulator. Sets the variable output voltage regulator voltage to 3.3 V and enables the variable output voltage regulator and the reference voltage generator.

Declaration	static uint8_t R5F10FMx_REG_SET_SHOCK_SENSOR(void)
Overview	Analog block initialization function
Parameters	None
Return value	0: Successful
	1: Communication with the analog block failed
Description	 Calls the R5F10FMx_Send_Receive function to initialize the functions in the analog block. Configures configurable amplifier Ch1 (differential amplifier) and configurable amplifier Ch2 (non-inverting amplifier) as shown in this application note. Sets the D/A converter channels Ch1 and Ch2 output voltage. Enables D/A converter channels Ch1 and Ch2 and configurable amplifier channels Ch1 and Ch2.

Declaration	<pre>void R_Systeminit(void)</pre>
Overview	MCU initialization function
Parameters	None
Return value	None
Description	 Initializes the peripheral hardware in the MCU used in this application note. Calls the R_PORT_Create function to initialize the ports. Calls the R_CGC_Create function to initialize the clock generator. Calls the R_SAU1_Create function to initialize the 3-wire serial I/O (CSI21) of channel 1 in serial array unit 1.

Declaration	void hdwinit(void)
Overview	System initialization function
Parameters	None
Return value	None
Description	Disables interrupts.
	Calls the R_Systeminit function to initialize the MCU.
	Enables interrupts.

Declaration	<pre>void R_CGC_Create(void)</pre>
Overview	Clock generator initialization function
Parameters	None
Return value	None
Description	Initializes the clock generator.

Declaration	<pre>void R_PORT_Create(void)</pre>
Overview	Port initialization function
Parameters	None
Return value	None
Description	Initializes the ports.

Declaration	void Refresh_PeakHoldVoltage(void)
Overview	Peak detector control function
Parameters	None
Return value	None
Description	Outputs a low level from the P04 pin (N-ch open drain output) for 100 µs to control resetting of the voltage held by the peak detector.

Declaration	void R_SAU1_Create(void)
Overview	SAU1 initialization function
Parameters	None
Return value	None
Description	Initializes serial array unit 1.

Declaration	<pre>void R_CSI21_Create(void)</pre>
Overview	CSI21 initialization function
Parameters	None
Return value	None
Description	Initializes the 3-wire serial I/O (CSI21) of channel 1 in serial array unit 1.

Declaration	void R_CSI21_Start(void)
Overview	CSI21 operation start function
Parameters	None
Return value	None
Description	Clears the INTCSI21 interrupt flag.
	Enables the INTCSI21 interrupt.
	Starts CSI21 operation.

Declaration	<pre>void R_CSI21_Stop(void)</pre>
Overview	CSI21 operation stop function
Parameters	None
Return value	None
Description	Stops CSI21 operation.
	Disables the INTCSI21 interrupt.
	Clears the INTCSI21 interrupt flag.

Declaration	MD_STATUS R_CSI21_Send_Receive(uint8_t * const tx_buf, uint16_t tx_num,
	<pre>uint8_t * const rx_buf)</pre>
Overview	CSI21 transmission/reception function
Parameters	uint8_t * const tx_buf: Address of transmission buffer
	uint16_t tx_num: Number of transmitted bytes
	uint8_t * const rx_buf: Address of reception buffer
Return value	MD_STATUS: Reception status
	MD_OK (0000H): Successful
	MD_ARGERROR (0081H): Argument input error
Description	Controls transmission and reception via CSI21.

Declaration	interrupt static void r_csi21_interrupt(void)
Overview	INTCSI21 interrupt service function
Parameters	None
Return value	None
Description	Services the CSI21 buffer empty interrupt or reception completion interrupt.

Declaration	static void r_csi21_callback_receiveend(void)
Overview	CSI21 reception completion function
Parameters	None
Return value	None
Description	Controls the operation when CSI21 reception ends.
	- Outputs a high level from the P73 pin.
	- Calls the R_CSI21_Stop function to stop CSI21 operation.

Declaration	<pre>uint8_t R5F10FMx_Send_Receive(uint8_t *p_read_data, uint8_t addr,</pre>
	uint8_t txdata, uint8_t command)
Overview	Function for performing SPI communication with the analog block
Parameters	uint8_t *p_read_data: Address at which to store the read data
	uint8_t addr: Address of the SPI control register
	uint8_t txdata: Data to transmit
	uint8_t command: Variable to specify read or write
	0: Read
	1: Write
Return value	0: Successful
	1: Communication with the analog block timed out or the analog block is in the reset state.
Description	Reads the status of the reset pin in the analog block and, if the pin is being reset, returns 1
	and ends processing.
	Calls the R_CSI21_Start function to start CSI21 operation.
	• Sets the data to be read or written. If the parameter command is set to 0 or a value other than
	1, returns 1 and ends processing.
	Outputs a low level from the P73 pin.
	Calls the R_CSI21_Send_Receive function to transmit or receive data.
	Stores the received data in *p_read_data.
	Returns 0 if execution finishes successfully and ends processing.

Declaration	<pre>void R_ADC_Create(void)</pre>
Overview	ADC initialization function
Parameters	None
Return value	None
Description	Initializes the A/D converter.

Declaration	<pre>void R_ADC_Start(void)</pre>
Overview	ADC operation start function
Parameters	None
Return value	None
Description	Clears the INTAD interrupt flag.
	Enables the INTAD interrupt.
	Enables operation of the D/A converter.

Declaration	<pre>void R_ADC_Stop(void)</pre>
Overview	ADC operation stop function
Parameters	None
Return value	None
Description	Stops operation of the D/A converter.
	Disables the INTAD interrupt.
	Clears the INTAD interrupt flag.

Declaration	<pre>void R_ADC_Set_OperationOn(void)</pre>
Overview	ADC comparator operation enable function
Parameters	None
Return value	None
Description	Enables operation of the A/D voltage comparator.

Declaration	<pre>void R_ADC_Set_OperationOff(void)</pre>
Overview	ADC comparator operation stop function
Parameters	None
Return value	None
Description	Stops operation of the A/D voltage comparator.

Declaration	<pre>void R_ADC_Get_Result(uint16_t * const buffer)</pre>
Overview	A/D conversion result read function
Parameters	uint16_t * const buffer: Address at which to store the A/D conversion results
Return value	None
Description	Reads the ADCR value and stores it in * const buffer.

Declaration	interrupt static void r_adc_interrupt(void)
Overview	INTAD interrupt service function
Parameters	None
Return value	None
Description	Reads the A/D conversion result from the 12-bit A/D conversion result register (ADCR) and stores it in _ad_buffer.

Declaration	<pre>void ADC_Trigger_Start(void)</pre>
Overview	ADC trigger operation start function
Parameters	None
Return value	None
Description	Calls the R_ADC_Start function to start operation of the A/D converter.
	• Calls the R_TAU0_Channel1_Start function to start operation of channel 1 in timer array
	unit 0.

Declaration	<pre>void ADC_Trigger_Stop(void)</pre>
Overview	ADC trigger operation stop function
Parameters	None
Return value	None
Description	Calls the R_ADC_Stop function to stop operation of the A/D converter.
	Calls the R_TAU0_Channel1_Stop function to stop operation of channel 1 in timer array
	unit 0.

Declaration	<pre>void ADC_Get_AD_Buffer_Value(uint16_t *dest)</pre>
Overview	A/D conversion result acquisition function
Parameters	uint16_t *dest: Address at which to store the A/D conversion results read from the
	ADCR register.
Return value	None
Description	Reads the A/D conversion results stored in the internal RAM.

Declaration	<pre>void R_TAU0_Create(void)</pre>
Overview	TAU0 initialization function
Parameters	None
Return value	None
Description	Initializes timer array unit 0.
Declaration	void R_TAU0_Channel1_Start(void)
Overview	TAU0 ch1 counter operation start function
Parameters	None
Return value	None
Description	Starts counting using channel 1 in timer array unit 0.
Declaration	<pre>void R_TAU0_Channel1_Stop(void)</pre>
Overview	TAU0 ch1 counter operation stop function
Parameters	None
Return value	None
Description	Stops counting using channel 1 in timer array unit 0.
Daglagation	
Declaration	void R_TAU0_Channel3_Start(void)
Overview Parameters	TAU0 ch3 counter operation start function None
Return value	None
Description	Starts counting using channel 3 in timer array unit 0.
Description	Starts counting using channel 3 in timer array unit 0.
Declaration	void R_TAU0_Channel3_Stop(void)
Overview	TAU0 ch3 counter operation stop function
Parameters	None
Return value	None
Description	Stops counting using channel 3 in timer array unit 0.
	1 1 0 - 2
Declaration	void TAU0_Channel3_ChangeTimerCondition(uint16_t regvalue)
Overview	TAU0 ch3 counter value change function
Parameters	uint16_t regvalue: Counter value set to TDR03
Return value	None
	Sets the value of the regvalue parameter to TDR03.
Description	Sets the value of the regyatte parameter to TDR03.

Declaration	<pre>void TAU0_WAIT_1ms(uint32_t wait_1ms)</pre>
Overview	1-ms unit wait function
Parameters	uint32_t wait_1ms: 1-ms counter
Return value	None
Description	 Calls the R_TAU0_Channel3_Stop function to stop counting using channel 3 in timer array unit 0. Calls the TAU0_Channel3_ChangeTimerCondition function to set the interval of channel 3 in timer array unit 0 to 1 ms. Calls the R_TAU0_Channel3_Start function to start counting using channel 3 in timer array unit 0. Decrements the value of the wait_1ms parameter for the interval of channel 3 in timer array unit 0 (1 ms) until the value becomes 0.

Declaration	<pre>void TAU0_WAIT_lus(uint32_t wait_lus)</pre>
Overview	1-µs unit wait function
Parameters	uint32_t wait_1us: 1-us counter
Return value	None
Description	 Calls the R_TAU0_Channel3_Stop function to stop counting using channel 3 in timer array unit 0. Calls the TAU0_Channel3_ChangeTimerCondition function to set the interval of channel 3 in timer array unit 0 to 1 μs. Calls the R_TAU0_Channel3_Start function to start counting using channel 3 in timer array unit 0. Decrements the value of the wait_1us parameter for the interval of channel 3 in timer array unit 0 (1 μs) until the value becomes 0.

Declaration	<pre>void write_lcd(uint8_t data, uint8_t rs)</pre>
Overview	LCD module write function
Parameters	uint8_t data: Data to be written to the LCD module
	uint8_t rs: LCD write mode (0: Command, 1: Data)
Return value	None
Description	Divides the data to be written to the LCD module, which is specified by the uint8_t data parameter, into the upper 4 bits and lower 4 bits and writes the data to the LCD module in the mode specified by the uint8_t rs parameter.

Declaration	void LCD_Init(void)	
Overview	D module initialization function	
Parameters	None	
Return value	None	
Description	Initializes the LCD module (in 4-bit interface mode)	

Declaration	<pre>void lcd_puts(int8_t *str)</pre>		
Overview	Character string display function		
Parameters	nt8_t *str: Address of the array in which to store the character string to be displayed on the LCD		
Return value	None		
Description	Displays the character string stored in the array on the LCD module.		

Declaration	<pre>void LCD_Sensor_Out(float result, int8_t *Unit, float adc_result)</pre>		
Overview	LCD module measurement result display function		
Parameters	float result: Calculated physical quantity		
	int8_t *Unit: Unit of calculated physical quantity		
	float adc_result: A/D conversion result average value		
Return value	None		
Description	Calls the LCD module write function to write the data to display on the LCD module.		
	 Displays XXX.X[Y] on the first line of the LCD. XXX.X indicates the calculated physical quantity, and Y indicates the unit (G). Displays ADC: ZZZH on the second line of the LCD. ZZZ indicates the A/D conversion result average value in hex. 		

Declaration	roid LCD_Err_Display(void)		
Overview	D module error display function		
Parameters	None		
Return value	ne		
Description	 Displays an error message on the LCD module if an SPI communication error occurs when the analog block initialization function is being called. Displays "PLEASE RESET" on the LCD module. 		

7.3.5 RAM variables

Table 7.3 RAM Variables

Data Type	Variable Name	Description	Function Used
volatile	gp_csi21_rx_address	Address of CSI21	R_CSI21_Send_Receive
uint8_t *		reception buffer	r_csi21_interrupt
volatile	g_csi21_rx_length	Number of bytes	Not used
uint16_t		received at CSI21	
volatile	g_csi21_rx_count	CSI21 received byte	Not used
uint16_t		counter	
volatile	gp_csi21_tx_address	Address of CSI21	R_CSI21_Send_Recieve
uint8_t *		transmission buffer	r_csi21_interrupt
volatile	g_csi21_send_length	Number of bytes	R_CSI21_Send_Receive
uint16_t		transmitted from CSI21	r_csi21_interrupt
volatile	g_csi21_tx_count	CSI21 transmitted byte	R_CSI21_Send_Receive
uint16_t		counter	r_csi21_interrupt
static uint16_t	_ad_buffer	Stores the A/D	r_adc_interrupt
		conversion result.	ADC_Get_AD_Buffer_Value

7.3.6 Flowcharts

Figure 7.15 shows an overview of the processing flow used in this application note. Flowcharts for the major functions are shown in the subsequent figures.

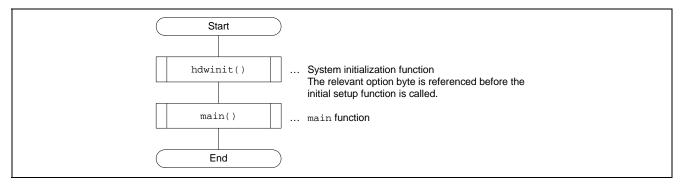


Figure 7.15 Overview of Processing Flow

(1) System initialization function (hdwinit)

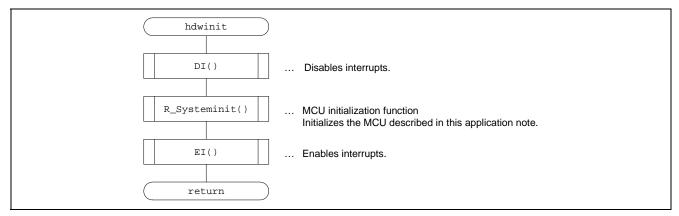


Figure 7.16 Flowchart of hdwinit Function

(2) MCU initialization function (R_Systeminit)

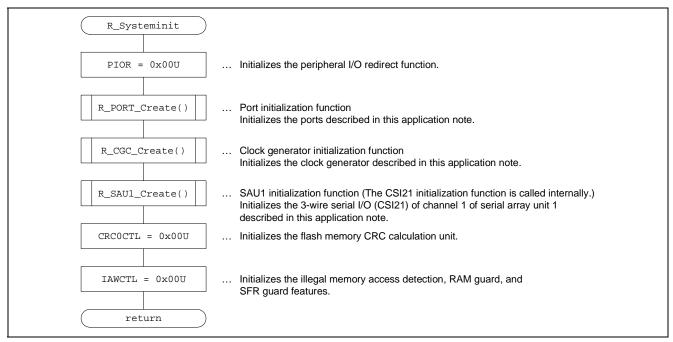


Figure 7.17 Flowchart of R_Systeminit Function

(3) ain function (main)

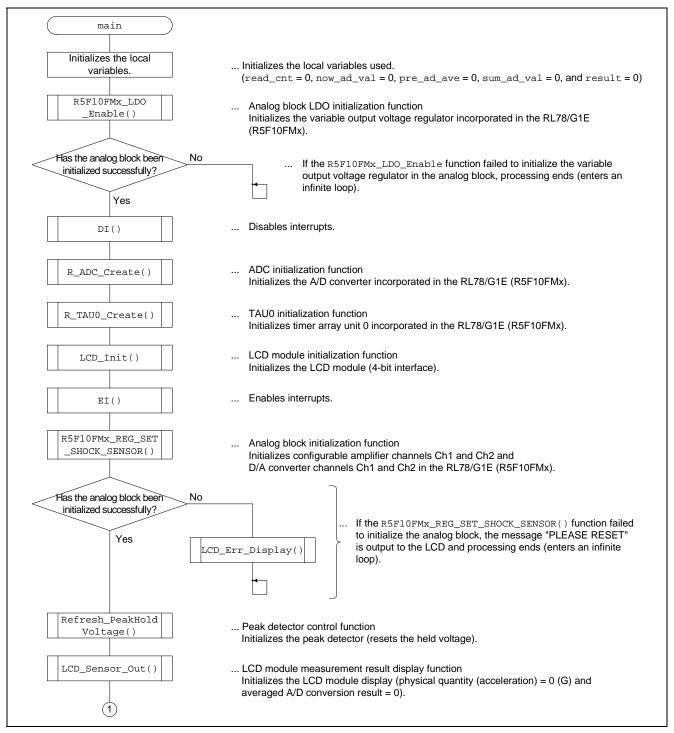


Figure 7.18 Flowchart of main Function (1)

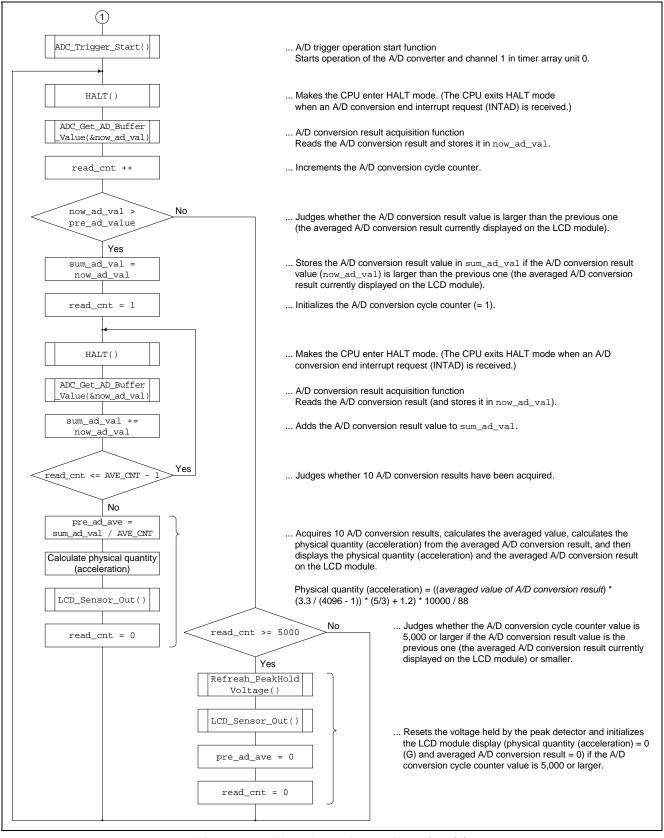


Figure 7.19 Flowchart of main Function (2)

(4) Analog block LDO initialization function (R5F10FMx_LDO_Enable)

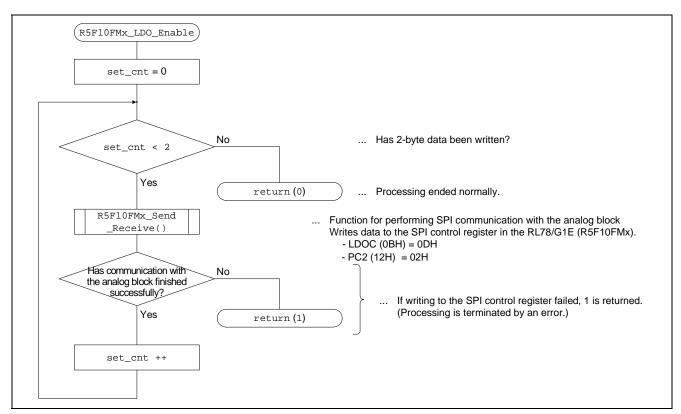


Figure 7.20 Flowchart of R5F10FMx_LDO_Enable Function

(5) Analog block initialization function (R5F10FMx_REG_SET_SHOCK_SENSOR)

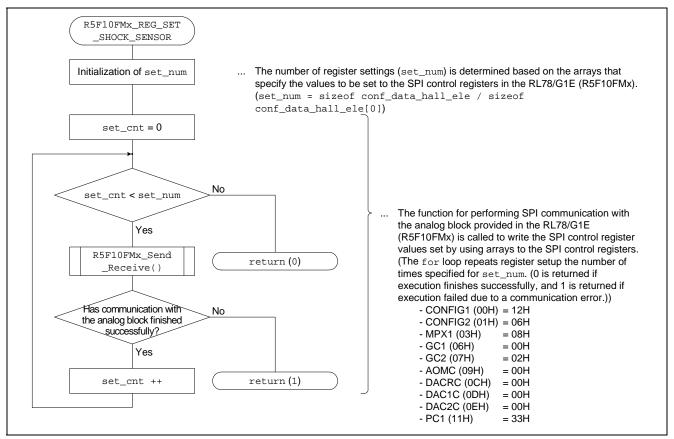


Figure 7.21 Flowchart of R5F10FMx_REG_SET_SHOCK_SENSOR Function

(6) Function that performs SPI communication with analog block (R5F10FMx_Send_Receive)

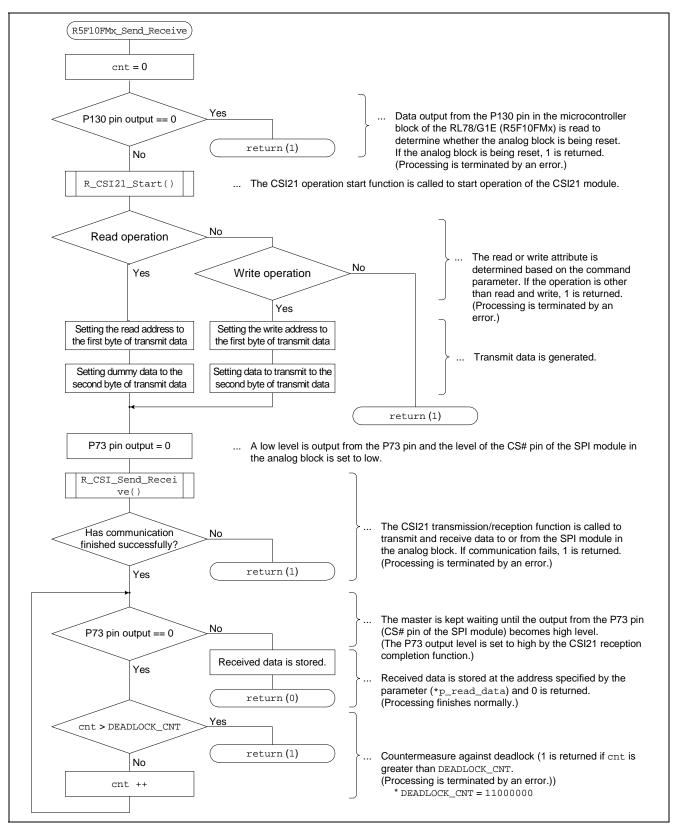


Figure 7.22 Flowchart of R5F10FMx_Send_Receive Function

(7) CSI21 reception completion function (r_csi21_callback_receiveend)

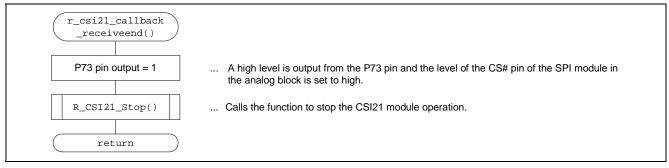


Figure 7.23 Flowchart of $r_{csi21_callback_receiveend}$ Function

(8) Peak detector control function (Refresh_PeakHoldVoltage)

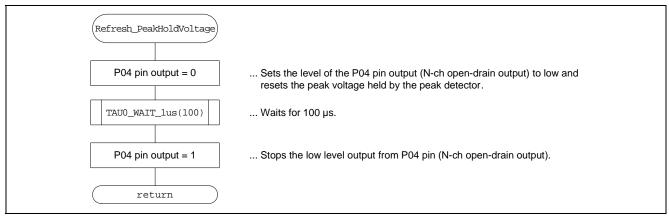


Figure 7.24 Flowchart of Refresh_PeakHoldVoltage Function

7.3.7 Source files and changes applied to the code output from the code generator

The sample code used in this application note was created based on the code for the RL78/G1A group (R5F10ELE) output by the code generator of CubeSuite+.

The output file has been modified to apply the differences between the RL78/G1A (R5F10ELE) and RL78/G1E (R5F10FME) such as incorporated registers. **Table 7.4** shows the changes applied to the code output by the code generator. For details about the differences between the RL78/G1A (R5F10ELE) and RL78/G1E (R5F10FME), see the *RL78/G1E Hardware User's Manual*.

Table 7.4 Source Files and Changes Applied to the Code Output from the Code Generator (1/2)

File Name	Description	Changes Applied to the Code Output by the Code Generator	
		Item	Description
r_main.c	Output by the code generator	-	_
r_systeminit.c	Output by the code generator	R_systeminit function	 Commented out R_ADC_Create();. Commented out R_TAU0_Create();.
r_cg_cgc.c	Output by the code generator	R_CGC_Create function	 Changed the value set to CMC =; Commented out XSTOP =; Commented out CSS =;
r_cg_cgc_user.c	Output by the code generator	-	_
r_cg_port.c	Output by the code generator	R_PORT_Create function	 Commented out P6 =; Commented out P12 =; Commented out P15 =; Commented out PMC4 =; Changed the value set to ADPC =;
r_cg_port_user.c	Output by the code generator	-	-
r_cg_serial.c	Output by the code generator	R_CSI21_Create function	 Commented out SO1 =; Commented out SO1 &=;
r_cg_serial_user.c	Output by the code generator	r_csi21_callback _receiveend function	Added processing.
r_cg_adc.c	Output by the code generator	R_ADC_Create function	 Commented out PM2 =; Commented out PM15 =; Commented out PM12 =; Commented out PMC3 =; Commented out PM3 =;
r_cg_adc_user.c	Output by the code generator	r_adc_interrupt function	Added processing.
r_cg_timer.c	Output by the code generator	R_TAU0_Create function	 Commented out TOM0 &=; Commented out TOL0 &=; Commented out TO0 &=; Commented out TOE0 &=;
r_cg_timer_user.c	Output by the code generator	-	_
r_cg_macrodriver.h	Output by the code generator	_	_

Table 7.5 Source Files and Changes Applied to the Code Output from the Code Generator (2/2)

File Name	Description	Changes Applied to the Code Output by the Code Generator	
		Item	Description
r_cg_userdefine.h	Output by the code generator	-	Added the typedef and define statements.
r_cg_cgc.h	Output by the code generator	-	Added the extern statement.
r_cg_port.h	Output by the code generator	-	Added the extern statement.
r_cg_serial.h	Output by the code generator	_	Added the extern statement.
r_cg_adc.h	Output by the code generator	_	Added the extern statement.
r_cg_timer.h	Output by the code generator	_	Added the extern statement.
lcd.c	LCD module control	-	-
lcd.h	Header file for	_	-

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Revision Record

		Description	
Rev.	Date	Page	Summary
1.00	Sep. 30, 2012	_	First edition issued.
1.10	Sep. 30, 2013		Some descriptions are modified.

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

- Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.
- The input pins of CMOS products are generally in the high-impedance state. In operation with unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

- The state of the product is undefined at the moment when power is supplied.
- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
 In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

- Access to reserved addresses is prohibited.
- The reserved addresses are provided for the possible future expansion of functions. Do not access
 these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

- After applying a reset, only release the reset line after the operating clock signal has become stable.
 When switching the clock signal during program execution, wait until the target clock signal has stabilized.
- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

- Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.
- The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

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